# Chapter 1 Hardware Overview

# Chapter 1 Contents

1.1	Feature	es	
1.2	Solid S	tate Drive(SSD)	
1.3	Power	Supply	
1.4	Batteri	es	
	1.4.1	Main Battery	
	1.4.2	Battery Charging Control	

# Figures

Figure 1-1	ID Parts Description Placement - Satellite C30-K	1-8
Figure 1-2	ID Parts Description Placement - Satellite C40-K	1-8
Figure 1-3	ID Parts Description Placement - Satellite C50-K	1-8
Figure 1-3	Block Diagram Description	1-9

# Tables

Table 1-1	SSD Device Comparison Table	1-12
Table 1-2	Quick/Normal Charging Time	1-14

# **1.1** Features

The Dynabook Satellite C30-K/C40-K/C50-K is a full-size PC notebook equipped with an Intel processor, providing high-speed processing capabilities and advanced features. The computer employs a lithium ion battery that allows it to be battery-operated for long periods of time. The display uses a 13.3-inch HD/FHD ; 14.0-inch HD/FHD ; 15.6-inch HD/FHD LCD panel. Many features can be Built To Order (BTO) to customize the system for each user.

The computer has the following features:

### □ Processor (BTO)

The computer is equipped with one of the following Intel<sup>®</sup> processors:

For Alder Lake platform

- Intel® Core i7-1265U 2C/8c, 1.8G
- Intel<sup>®</sup> Core i7-1255U 2C/8c, 1.7G
- Intel<sup>®</sup> Core i5-1245U 2C/8c, 1.6G
- Intel® Core i5-1235U 2C/8c, 1.3G
- Intel® Core i3-1215U 2C/4c, 1.2G
- Intel® Celeron 7305 1C/4c, 1.1G
- Intel® Core i7-1260P 4C/8c, 2.1G
- Intel® Core i5-1240P 4C/8c, 1.7G

### □ Memory (BTO)

- Two SODIMM slots which come standard with DDR-4 3200MHz 4GB/8GB/16GB, accepting BTO customization for your memory requirements.
- It can incorporate up to 32GB of main memory.
- Battery Pack

The computer is powered by one 3 or 4-cell lithium ion battery pack with a capacity of 45Wh or 53Wh, which is rechargeable and removable.

□ Solid-State Drive (SSD) (BTO)

The computer accommodates a 2280 SSD with the followingstorage capacities:

- PCIe SSD M.2 128GB/256GB/512GB
- PCIe gen3/gen4 M.2 512GB/1TB

Display (BTO)

The LCD display comes with either one of the following non-touch panels.

- 13.3"W 16:9 HD (1366×768) eDP 1.4b Non CSV LED display
- 13.3"W 16:9 FHD (1920×1080) eDP 1.4b Non CSV LED display
- 14.0"W 16:9 HD (1366×768) eDP 1.4b Non CSV LED display
- 14.0"W 16:9 FHD (1920×1080) eDP 1.4b Non CSV LED display
- 15.6"W 16:9 HD (1366×768) eDP 1.4b Non CSV LED display
- 15.6"W 16:9 FHD (1920×1080) eDP 1.4b Non CSV LED display

# Graphics (BTO)

■ Intel® Iris® Xe Graphics(i5/i7), Intel HD Graphics(others)

# □ Keyboard (BTO)

- 13.3 inch The keyboard which has 83(US)/ 84(UK/ 86(JPN), 1.4±0.2mm full stroke keys.
- 14 inch The keyboard which has 83(US)/ 84(UK/ 86(JPN), 1.4±0.2mm full stroke keys.
- 15.6 inch The keyboard which has 102(US)/ 103(UK/ 107(JPN), with number key. 1.4±0.2mm full stroke keys.

## Pointing Device

The integrated ClickPad performs finger touch and all the functions of a traditional mouse. Allow control of the on-screen pointer and also supports multi-touch function such as the scrolling of Windows.

## □ Finger Print Device

A fingerprint sensor is an electronic device used to capture a digital image of the fingerprint pattern. The captured image is called a live scan. This live scan is digitally processed to create a biometric template (a collection of extracted features) which is stored and used for matching. Many technologies have been used including Optical, Capacitive or CMOS, Ultrasound and Thermal scanners.

# □ Universal Serial Bus (USB) Ports

The computer has two(13-inch) or three(14/15-inch) USB 3.0 and one USB-C ports. It is supported to daisy-chain a maximum of 127 USB devices. The USB3.0 serial data transfer rate is up to 5 Gbps. The USB-C data transfer rate is up to 10Gbps. These ports support PnP installation and hot plugging.

#### 1 Hardware Overview

### Bridge Media Slot

This slot allows you to insert an Micro SD memorycard. It supports high-speed SD. UHS-I is also supported on SDXC up to SDR104. This model does not support CF or Smart Media cards.

- □ Sound system
  - Stereo Speaker (2 x speaker)
  - DTS Audio Processing for Japan model
  - Integrated Microphone
    - 2 x Mic
    - Support Beam Forming, Noise Suppression
  - Support Cortana Near Field

### □ Internal Camera

The computer has an internal camera it supports HD(0.9M) with camera shutter.

This camera module may come with the following types:

- Webcam HD: support capture still images/record video function
- Webcam HD & Face Authentication Sensor: support capture still images/record video/Facial recognition(Windows Hello) function
- Combo Audio Jack

This jack connects digital speakers, stereo headphones (16 ohm minimum), microphones, or combo stereo headphone & earphone. When connected to digital speakers or headphones, the internal speakers are automatically disabled.

It enables connection of a three-conductor microphone for monaural input and also enables the connection of a stereo device for audio input.

HDMI Out Port

The HDMI 1.4b out port can connect with a Type A connector HDMI cable. The HDMI out port can send up to 4K HDR video/audio signals.

Built-in LAN

The computer has built-in support for 10/100/1000M Gigabit. It employs a Realtek RTL8111H controller.

It supports wake-up on LAN form S4/S5 boot support.

### 1.1 Features

### Wireless LAN (BTO)

The computer is equipped with a Wireless LAN (WLAN) card. This WLAN module may come with the following types:

- 802.11AX+BT-M.2(1 × 1)
- 802.11AX+BT-M.2(2 × 2)
- Intel 802.11 (a/b/g/n/ac/ax) AX201

□ Bluetooth (BTO)

Some computers in this series offer Bluetooth wireless communication function which eliminates the need for cables between electronic devices such as computers and printers. When implemented, Bluetooth provides wireless communication in a small space. This module is Version 5.0 or later support (combo module with WLAN), and supports Microsoft stack.

Figures 1-1 to 1-4 show the computer and its system unit configuration.



Figure 1-1 ID Parts Description Placement - Satellite C30-K







Figure 1-4 Block Diagram Description

The system unit of the computer consists of the following components:

Processor (BTO)

The computer is equipped with one of the following Intel<sup>®</sup> processors:

For Alder Lake platform

- Intel® Core i7-1265U 2C/8c, 1.8G
- Intel® Core i7-1255U 2C/8c, 1.7G
- Intel® Core i5-1245U 2C/8c, 1.6G
- Intel® Core i5-1235U 2C/8c, 1.3G
- Intel® Core i3-1215U 2C/4c, 1.2G
- Intel® Celeron 7305 1C/4c, 1.1G
- Intel® Core i7-1260P 4C/8c, 2.1G
- Intel® Core i5-1240P 4C/8c, 1.7G

### □ Memory (BTO)

- Two SODIMM slots which come standard with DDR-4 3200MHz 4GB/8GB/16GB, accepting BTO customization for your memory requirements.
- It can incorporate up to 32GB of main memory.

### BIOS ROM (EEPROM)

The system BIOS uses one 16MB flash ROM(for BIOS) and one 8MB flash ROM(for INTEL ME). The flash utility can be used to program system and keyboard BIOS at the same time.

- □ System Controllers
  - Support SMBus specification V2.0
  - Hot keys for system control
  - Audio volume control
  - Battery status report and control
  - Power switch control
  - Support three independent devices
  - Internal Keyboard country selection
  - Wireless LAN on/off button

- Graphics Controller (BTO)
  - Supported Display Device:
    - Internal LCD
    - RGB
    - HDMI
  - DirectX11, AMD PowerXpress 5.5 (Muxless Switchable Graphics) supported
- □ Audio Controller
  - Realtek Azalia ALC233
  - One Audio combo port
  - Synchronize to change sound output to HDMI
  - Software EQ support
- □ Wireless LAN Controller (BTO)
  - Azurewave 802.11 (a/b/g/n/ac) RTL8821CE
  - Azurewave 802.11 (a/b/g/n/ac/ax) RTL8852BE
  - Intel 802.11 (a/b/g/n/ac/ax) AX201
- □ KBC/EC (Keyboard Controller/Embedded Controller)
  - KBC
    - Scan controller function
    - Interface controller function
  - EC
    - Power supply sequence control
    - Overheat shutdown support
    - LED control
    - Device ON/OFF
    - Cooling fan speed control
    - Universal I/O port
    - Battery capacity check
    - Flash memory reprogramming function
    - EC access interface
    - I2C communication control

## **1.2** Solid State Drive (SSD)

- 1. Form factor: M.2 2280
- 2. Interface: NVMe-PCIe Gen3 or Gen4
- 3. Capacity: 128GB, 256GB, 512GB, 1TB

Item	Read	Write	Data transfer rate	LBA	Bytes per sector
M.2 PCle Gen3 128G SSD	3,100MB/s	1,200MB/s	128KB	250,069,680	512Bytes
M.2 PCIe Gen3/4 256G SSD (DRAM less)	3,100MB/s	1,300MB/s	128KB	500,118,192	512Bytes
M.2 PCIe Gen3/4 512G SSD (DRAM less)	3,100MB/s	1,800MB/s	128KB	1,000,215,216	512Byte
M.2 PCle Gen4 512G SSD	6,400MB/s	2,700MB/s	128KB	1,000,215,216	512Byte
M.2 PCle Gen4 1TB SSD	6,600MB/s	5,000MB/s	128KB	2,000,409,264	512Byte

Table 1-1SSD Device Comparison Table

# **1.3** Power Supply

The power supply unit provides constant voltage (19V) for the system board and performs the following functions:

- 1. Power input monitor
  - Checks whether the AC adapter (DC power supply) is connected to the computer.
  - Checks whether the battery pack is connected to the computer.
  - Monitors the DC power supply input voltage (AC Adapter output voltage).
- 2. Power supply's internal control
  - Turns on and off the battery pack charging power supply.
  - Issues a charging current instruction to the PWM control IC of the battery pack charging power supply.
  - Controls the supply of DC power supply input (AC Adapter output) to the power supply unit.
  - Controls the supply of power to the system block (load/logic circuit side).
- 3. Logic circuit control
  - Instructs the gate array to enable/disable tuning the power on.
  - Controls power-on/off operation.

### 1.3 Power Supply

- 4. Status display
  - Turns on the Power LED (in White).
  - DC-IN/Battery indicator (in White/Amber-Blink)
  - Camera indicator (in White)
- 5. External interface
  - Performs communication through the I2C bus (via the internal EC/KBC).
  - Transfers the power supply operation mode.
- 6. Output monitor
  - Monitors the voltage output to the system block (load/logic circuit side).
  - Monitors the voltage, over-voltage, input/output current of the battery pack.
  - Monitors the internal temperature of the battery pack.
  - Monitors the supply voltage from the AC adapter.

# **1.4 Batteries**

The computer is powered by one 4-cell / 3-cell lithium ion main battery pack:

- □ 3cell (3S1P) of LI-ION 4050mAH polymer 467866 size with 45Wh
- □ 4cell (4S1P) of LI-ION 3550mAH polymer 476371 size with 53Wh

### 1.4.1 Main Battery

The main battery pack serves as the computer's main power source when the AC adapter is not attached. The main battery maintains the state of the computer when the AC adapter is detached.

### **1.4.2 Battery Charging Control**

Battery charging is controlled by ISL9538. When the AC adapter and battery pack are attached to the computer, the ISL9538 controls the charge on/off state and detects a full charge.

Battery Charge

When the AC adapter is attached, the battery is charged by off-state charge when the system is powered off or by on-state charge when it is powered on.

State	Charge Time	
	Battery pack (4050mAh, 3cell)	3 hours
On-State Charge	Battery pack (3550mAh, 4cell)	4 hours
On State Change	Battery pack (4050mAh, 3cell)	12 hours
On-State Charge	Battery pack (3550mAh, 4cell)	12 hours

Table 1-2Quick/Normal Charging Time

**NOTE:** The time required for normal charge depends on the power consumption by the system. Using a fluorescent lamp and frequently accessing the disk consumes more power and lengthens the charge time.

Any of the following can stop the battery from charging:

- 1. The battery becomes fully charged.
- 2. The AC adapter or battery pack is removed.
- 3. The battery or AC adapter voltage is abnormal.
- Detection of full charge

A full charge is detected only when the battery is being charged by quick or normal charge. A full charge is detected when either of the following conditions are met:

- 1. The current in the battery charging circuit drops below the predetermined value.
- 2. The charging time exceeds the fixed limit.

# Chapter 2

# **Troubleshooting Procedures**

#### Chapter 2 Contents 2.1Troubleshooting Introduction ..... 2-2.2 Troubleshooting Flowchart..... 2-2.3 2.4 2.5 2.6 2.7 2.8 2.9 2.10 2.11 Bluetooth Troubleshooting ..... 2 - 282.12 SD Troubleshooting ...... 2-30 2.13 2.14 2.15 2.16 2.17 2.18 2.19 LED Troubleshooting ...... 2-44 2.20 2.21 2.22

# Figures

Figure 2-1	Troubleshooting flowchart (2/1)
Figure 2-1	Troubleshooting flowchart (2/2)
Figure2-2	Power Supply Troubleshooting Process
Figure 2-3	Display troubleshooting process
Figure 2-4	Keyboard troubleshooting process
Figure 2-5	External USB device troubleshooting process
Figure 2-6	TouchPad troubleshooting process
Figure 2-7	Speaker troubleshooting process
Figure 2-8	Wireless LAN troubleshooting process
Figure 2-9	Camera Troubleshooting process
Figure 2-10	Bluetooth troubleshooting process
Figure 2-11	SD card troubleshooting process
Figure 2-12	SSD troubleshooting process
Figure 2-13	HDMI troubleshooting process
Figure 2-14	MIC troubleshooting process
Figure 2-15	TYPE C troubleshooting process
Figure 2-16	LAN troubleshooting process
Figure 2-17	Battery troubleshooting process
Figure 2-18	LED troubleshooting process
Figure 2-19	FAN troubleshooting process
Figure 2-20	Memory troubleshooting process
Figure 2-21	Finger Print troubleshooting process

# Tables

Table 2-1	Battery LED	.0
Table 2-2	DC-IN LED	1

# 2.1 Troubleshooting Introduction

Chapter 2 describes how to determine if a Field Replaceable Unit (FRU) in the computer is causing the computer to malfunction. The FRUs covered are:

1. Display	7. Wire LAN	13. USB3.0	19. Headphone
2. Keyboard	8. Camera	14. LAN	20. Memory
3. USB ports	9. Bluetooth	15.HDD/SSD	21. Finger Print
4. MIC	10. HDMI	16. Battery	
5. Touch Pad	11. TYPE C	17. LED	
6. Speaker	12. SD	18.FAN	

The Diagnostics Disk operations are described in Chapter 3. Detailed replacement procedures are given in Chapter 4.

The following tools are necessary for implementing the troubleshooting procedures:

- 1. Multi-meter
- 2. External monitor –HDMI
- 3. USB compatible keyboard
- 4. Multimedia sound system with line-in and line-out ports
- 5. Headphones
- 6. USB test module and USB cable
- 7. MIC module and MIC line
- 8. Audio loop back
- 9. USB3.0 HDD
- 10. HDMI
- 11. T&D for diagnostics program

# 2.2 Troubleshooting Flowchart

If you know the location of the malfunction, turn directly to the appropriate section of this chapter. If the problem is unspecified, use the flowchart in Figure 2-1 as a guide for determining which troubleshooting procedures to execute. Before performing any troubleshooting procedures, verify the following:

- Ask the user if a password is registered, if it is, ask him or her to enter the password.
- Verify with the customer that Windows 11 is installed on the hard disk (SSD). Operating systems that were not pre-installed by Dynabook can cause the computer to malfunction.
- Make sure all optional equipment is removed from the computer



Figure 2-1 Troubleshooting flowchart (1/2)



Figure 2-1 Troubleshooting flowchart (2/2)

If the diagnostics program cannot detect an error, the problem may be intermittent. The test program should be executed several times to isolate the problem. When a problem has been located, perform the appropriate troubleshooting procedures as follows:

- 1. If an error is detected by the battery test, perform the Power Supply Troubleshooting procedures in Section 2.3
- 2. If an error is detected by the display test, perform the Display Troubleshooting procedures in Section 2.4
- 3. If an error is detected by the keyboard test, perform the Keyboard Troubleshooting procedures in Section 2.5
- 4. If an error is detected by the Touchpad test, perform the Touchpad Troubleshooting procedures in Section 2.7
- 5. If an error is detected by the audio test, perform the Speaker Troubleshooting procedures in Section 2.8
- 6. If an error is detected when using the SSD, perform the SSD Troubleshooting procedures in Section 2.13
- 7. If an error is detected when using the LAN, perform the LAN troubleshooting procedures in Section 2.18
- 8. If an error is defected when using the battery, perform the Battery troubleshooting procedures in Section 2.19
- 9. If an error is defected when using LED function, perform the LED troubleshooting procedures in Section 2.20
- 10. If an error is defected when using FAN ,perform the FAN troubleshooting procedures in Section 2.21
- 11. If an error is defected when using Memory ,perform the Memory troubleshooting procedures in Section 2.22
- 12. If an error is defected when using Finger Print ,perform the Memory troubleshooting procedures in Section 2.23

Other problems that are not covered by the diagnostics program may be discovered by a user.

- 1. If an error is detected when using an external USB device, perform the External USB Devices Troubleshooting procedures in Section 2.6
- 2. If an error is detected when using the Wireless LAN, perform the Wireless LAN Troubleshooting procedures in Section 2.9
- 3. If an error is detected when using the camera, perform the camera Troubleshooting procedures in Section 2.10
- 4. If an error is detected when using the Bluetooth, perform the Bluetooth Troubleshooting procedures in Section 2.11
- 5. If an error is detected when using the SD, perform the SD Troubleshooting procedures in Section 2.12
- 6. If an error is detected when using the HDMI TV, perform the HDMI troubleshooting procedures in Section 2.14
- 7. If an error is detected when using the MIC, perform the MIC troubleshooting procedures in Section 2.15
- 8. If an error is detected when using the USB3.0&USB2.0, perform the USB3.0&USB2.0 troubleshooting procedures in Section 2.16
- 9. If an error is detected when using The TYPE C, perform TYPE C troubleshooting procedures in Section 2.17



# 2.3 Power Supply Troubleshooting

Figure 2-2 Power Supply Troubleshooting Process

The power supply controls many functions and components. To determine if the power supply is functioning properly, start with Procedure 1 and continue with the other Procedures as instructed. The flowchart in Figure 2-2 gives a summary of the process. The procedures described in this section are:

Procedure 1:	Power status check
Procedure 2:	Adaptor / battery replacement
Procedure 3:	Power supply connection check
Procedure 4:	Diagnostic check
Procedure 5:	Internal connection check

### Procedure 1 Power Status Check

The following LEDS indicate the power supply status:



Battery LED

DC-IN LED

The power supply controller displays the power supply status through the Battery and the DC-IN LEDS as listed in the tables below.

<b>Battery State</b>	LED colors	Definition
Charging	Amber, solid on	Battery charging with AC.
	White, solid on	Battery fully charged by AC
	Amber color off	Battery abnormal stop charging with AC (Bad cell/ Overheated)
Discharging	Amber, blinking (LED on for 1 second every 4 seconds)	Battery within low state: 12 minutes remaining
	Amber, blinking (LED on for 1 second every 2 seconds)	Battery within critical low state: 3 minutes remaining. The system is protected and cannot be re-powered on without the AC power connected.
	Amber color off	Battery not in low or critical low state; It's in discharging state

Table 2-1 Battery LED

AC-IN LED	Power supply status
Solid on	AC power exists (LED is solid White).
Off	No AC power exists.

Table 2-2 DC-IN LED

To check the power supply status, install a battery pack and connect an AC adaptor to the DC-IN port on the computer and to a power supply.

If the DC-IN LED or Battery LED is not lit, go to Procedure 2.

## Procedure 2 Adaptor / battery replacement

A faulty adaptor may not supply power or may not charge the battery. Perform Check 1.

Check 1 Connect a new AC adaptor. If the problem is not resolved, go to Check 2.

Check 2 Insert a new battery. If the problem is still not resolved, go to Procedure 3.

## Procedure 3 Power supply connection check

The power supply wiring diagram is shown below:



Any of the connectors may be disconnected. Perform Check 1.

- Check 1 Disconnect the AC power cord from wall outlet. Check the power cable for breaks. If the power cord is damaged, connect a new AC power cord. If there is no damage, go to Check 2.
- Check 2 Make sure the AC adaptor cord and AC power cord are firmly plugged into the DC-IN socket, AC adaptor inlet and wall outlet. If these cables are connected correctly, go to Check 3.

- Check 3 Make sure that the DC-IN input port socket is firmly secured to the system board of the computer.
  - If the DC-IN input socket is loose, go to Procedure 5.
  - If it is not loose, go to Check 4.
- Check 4 Use a multi-meter to make sure that the AC adaptor output voltage is close to 19 V. If the output is several percent lower than 19 V, go to Check 5. If the output is close to 19 V, go to Check 6.
- Check 5 Connect a new AC adaptor or AC power cord.
  - If the DC-IN LED does not light, go to Procedure 4.
  - If the battery LED does not light, go to Check 6.
- Check 6 Make sure the battery pack is installed in the computer correctly. If the battery is properly installed and the battery LED still does not light, go to Procedure 4.

### Procedure 4 Diagnostic check

The power supply may not charge the battery pack. Perform the following procedures:

- 1. Reinstall the battery pack.
- 2. Attach the AC adaptor and turn on the power. If you cannot turn on the power, go to Procedure 5.
- 3. Run the Diagnostic test following the procedures described in Chapter 3, Tests and Diagnostics. If no problem is detected, the battery is functioning normally.

### Procedure 5 Replacement check

The system board may be disconnected or damaged. Disassemble the computer following the steps described in Chapter 4, *Replacement Procedures*. Check the connection between the AC adaptor and the system board. After checking the connection, perform Check 1:

- Check 1 Use a multi-meter to make sure that the fuses on the system board are not blown. If a fuse is not blown, go to Check 2. If a fuse is blown, go to Check 3.
- Check 2 Make sure that the battery cable is firmly connected to the system board. If it is connected firmly, go to Check 3.
- Check 3 The system board may be damaged. Replace it with a new one following the instructions in Chapter 4.



# 2.4 Display Troubleshooting

Figure 2-3 Display troubleshooting process

This section describes how to determine if the computer's display is functioning properly. The process is outlined in Figure 2-4. Start with Procedure 1 and continue with the other procedures as instructed.

Procedure 1: External display checkProcedure 2: Diagnostic checkProcedure 3: Connector and replacement check

## Procedure 1 External display check

Connect an external display to the computer's external monitor port, and then boot the computer. The computer automatically detects the external display.

If the external display works correctly, the internal LCD may be damaged. Go to Procedure 3.

If the external monitor appears to have the same problem as the internal monitor, the system board may be damaged. Go to Procedure 2.

# Procedure 2 Diagnostic check

The Display Test program is stored on the computer's Diagnostics disk. This program checks the display controller on the system board. Insert the Diagnostics disk in the computer's floppy disk drive, turn on the computer and run the test. Refer to Chapter 3, *Tests and Diagnostics* for details.

If an error is detected, go to Procedure 3. If an error is not detected, the display is functioning properly.

### Procedure 3 Connector and replacement check

The LCD module and system board are connected to the display circuits. Any of these components may be damaged. Refer to Chapter 4, *Replacement Procedures*, for instructions on how to disassemble the computer and then perform the following checks:

- Check 1 Make sure the DDR RAM module is seated properly. Test display again. If the problem still exits, replace the DDR RAM module. If the problem still exists, perform Check 2.
- Check 2 Replace the LCD module with a new one and test display again. If the problem still exists, perform Check 3.
- Check 3 Replace the LCD cable with a new one and test display again. If the problemstill exists, perform Check 4.
- Check 4 The system board may be damaged. Replace it with a new one.



# 2.5 Keyboard Troubleshooting

Figure 2-4 Keyboard troubleshooting process

To determine if the computer's keyboard is functioning properly, perform the following procedures. Figure 2-5 outlines the process. Start with Procedure 1 and continue with the other procedures as instructed.

### Procedure 1 Diagnostic check

Run the test and Diagnostics Program, which will automatically execute the Keyboard Test. Refer to Chapter 3, *Tests and Diagnostics* for more information on how to run the program.

If an error is located, go to Procedure 2. If an error does not occur, the keyboard is functioning ok.

### Procedure 2 Connector and replacement check

The keyboard and/or system board may be disconnected or damaged. Disassemble the computer following the steps described in Chapter 4, *Replacement Procedures* and perform the following checks.

Check 1 Make sure the keyboard cable is firmly connected to the system board.

If the connection is loose, reconnect firmly and repeat Procedure 1. If there is still an error, go to Check 2.

Check 2 The keyboard may be damaged. Replace it with a new one following the instructions in Chapter 4.

If the problem still exists, perform Check 3.

Check 3 The system board may be damaged. Replace it with a new one following the instructions in Chapter 4.





Figure 2-5 External USB device troubleshooting process

To determine if the computer's external USB devices are functioning properly, perform the following procedures. Figure 2-6 outlines the process. Start with Procedure 1 and continue as instructed.

Procedure 1: External device and connection check

Procedure 2: Replace system board or small board

### Procedure 1 External device and connection check

The USB device may be damaged or the connection may be faulty. Use windows application to check device can work fine or not. If an error is located, go to Perform Check 1. If an error does not occur, the USB is functioning ok.

- Check 1 Make sure USB device cable is firmly plugged into one of the USB sockets. If the cable is connected correctly, go to Check 2.
- Check 2 Plug the USB device into another USB socket (there are three in all). If the USB device still does not work, go to Check 4.

If the device functions correctly when connected to another USB port, go to Check 3.

- Check 3 Make sure that the USB socket is firmly secured to the system board of the computer. If the malfunction remains, the system board or USB small board may be damaged. Go to Procedure 2.
- Check 4 Connect an alternative USB device to one of the computer's USB ports, and then boot the computer. The computer automatically detects the external device.

If the alternative USB device works correctly, the original device may be damaged and should be replaced.

If the alternative USB device appears to have the same problem as the original device, the system board or USB small board may be damaged. Go to Procedure 2.

### Procedure 2 Replace system board

If the error persists, the system board or USB small board may be damaged. Replace it with a new one following the instructions in Chapter 4.



# 2.7 Touch Pad Troubleshooting

Figure 2-6 Touchpad troubleshooting process
To determine if the computer's built-in Touchpad is functioning properly, perform the following procedures. Figure 2-7 outlines the process. Start with Procedure 1 and continue as instructed.

Procedure 1: Diagnostic test in windows system

Procedure 2: Touchpad connection check

Procedure 3: Touchpad replacement check

## Procedure 1 Diagnostic test in windows system

**a.** Please check touch function in windows system or run the Diagnostic Program, which will automatically execute the Touchpadtest. (Refer to Chapter 3 system configuration check), Tests and Diagnostics for more information on the program.

**b.** If Diagnostic Program test PASS, please enter windows 8 to test 2 fingers zoom in/ zoom out test and check whether the function is OK or not.

If an error is located in **a** and **b** items, go to Procedure 2. If an error is not located, the Touchpad function is functioning properly.

## Procedure 2 Touchpad connection check

The Touchpad is connected via the Touchpad FPC to the system board. Make sure the Touchpad FPC cable is firmly connected to the Touchpad and system board. Refer to Chapter 4, *Replacement Procedures*, for instructions on how to disassemble the computer and then perform the following checks.

If any of the connections are loose, reconnect firmly. If any of the connections is damaged, or there is still an error, go to Procedure 3.

#### Procedure 3 Touchpad replacement check

The Touchpad unit or FPC may be defective or damaged. Replace each with a new one following the steps in Chapter 4. If under windows system test is still not functioning properly, replace the system board with a new one following the steps in Chapter 4.



## 2.8 Speaker Troubleshooting

Figure 2-7Speaker troubleshooting process

To determine if the computer's built-in speakers are functioning properly, perform the following procedures. Figure 2-8 outlines the process. First adjust the speaker volume to an appropriate level. Start with Procedure 1 and continue as instructed.

Procedure 1: Audio source testProcedure 2: Earphone testProcedure 3: Connection checkProcedure 4: Replacement check

## Procedure 1 Audio source test

Try different audio sources (e.g. an audio CD and digital music file) to determine whether the fault is in the speaker system or not. If not all sources have sound problem, the problem is in the source devices. If all have the same problem, continue with Procedure 2.

## Procedure 2 Earphone test

Connect a set if earphones or external speakers. If these function correctly, go to Procedure 3. If they do not function correctly, the system board may be defective or damaged. Replace it with a new one.

## Procedure 3 Connection check

Disassemble the computer following the steps described in Chapter 4, *Replacement Procedures* and make sure the speaker cable is firmly connected to the audio board. If the stereo speakers are still not functioning properly, go to Procedure 4.

## Procedure 4 Replacement check

If the stereo speakers don't sound properly, the stereo speakers may be defective or damaged. Replace them with new ones. If the stereo speakers still do not work properly, try replacing in turn the audio board and system board.



## 2.9 Wireless LAN Troubleshooting



Figure 2-8 Wireless LAN troubleshooting process

Notes: W/L Antenna assemble rule as below:

Color of antenna	Assemble location
White antenna	Main/1
Black antenna	Aux/2

The wireless LAN antenna wire, wireless LAN unit or system board may each be the source of a wireless LAN fault. Any of these components may be damaged. To determine if the computer's wireless LAN system is functioning properly, perform the following procedures. Figure 2-10 outlines the process. Start with Procedure 1 and continue with the other procedures as instructed.

Procedure 1:	Wireless LAN connection test
Procedure 2:	Connector and replacement check

## Procedure 1 Wireless LAN connection check

PLS use windows application. If an error is located, go to Procedure 2. If an error is not located, the wireless LAN system is functioning properly.

## Procedure 2 Connector and replacement check

The wireless LAN antenna, wireless LAN unit or system board may be disconnected or damaged. Disassemble the computer following the steps described in Chapter 4, *Replacement Procedures*, and perform the following checks.

- Check 1 Make sure that the wireless LAN antenna is firmly connected to the Wireless LAN module (refer to Chapter 4 for instructions) and that the wireless LAN module is securely slotted into the system board. If the problem persists, go to Check 2.
- Check 2 Check that the wireless communication switch is turned to "On", and then make sure that the wireless communication LED on the front panel is light. If the LED is light but the wireless LAN function is still faulty, the antenna may be damaged. Replace with a new antenna following the steps in Chapter 4, *Replacement Procedures*. If the problem persists, or if the wireless LAN LED is not light when the wireless communication switch is turned to "On", go to Check 3.
- Check 3 The wireless LAN unit may be damaged. Replace it with a new one following the instructions in Chapter 4. If the problem still exists, perform Check 4.
- Check 4 The system board may be damaged. Replace it with a new one following the instructions in Chapter 4.





Figure 2-9 Camera troubleshooting process

The Camera board or system board may be the reason of a Camera fault. Either of these two

components may be damaged. To determine if the computer's Camera is functioning

properly, perform the following procedures. Figure 2-10 outlines the process. Start with

Procedure 1 and continue with the other procedures as instructed.

Procedure 1: Windows Application test

Procedure 2: Connector and replacement check

#### Procedure 1 Windows Application test and check camera LED

Run the functioning Program in windows, which will display the Camera test result.

If tests and diagnostics result abnormal go to Procedure 2. If an error is not located, the Camera system is functioning properly.

#### Procedure 2 Camera LED, Connector and replacement check

The Camera board or system board may be disconnected or damaged. Disassemble the computer following the steps described in Chapter 4, *Replacement Procedures*, and perform the following checks.

- Check 1 Check camera LED, If the LED doesn't light, then Make sure that the Camera board FFC is securely slotted into the system board. If the problem persists, go to Check 2.
- Check 2 Make sure that the Camera board FFC is securely slotted into the system board. If the problem persists, go to Check 2.
- Check 3 The Camera board may be damaged. Replace it with a new one following the instructions in Chapter 4. If the problem still exists, perform Check 3.
- Check 4 The system board may be damaged. Replace it with a new one following the instructions in Chapter 4.





Figure 2-10 Bluetooth troubleshooting process

This is combine module that WLAN +Bluetooth function, The WLAN antenna wire, combine module or system board may be the reason of a Bluetooth fault. Any of these components may be damaged. To determine if the computer's Bluetooth is functioning properly, perform the following procedures. Figure 2-11utlines the process. Start with Procedure 1 and continue with the other procedures as instructed.

Procedure 1: Windows Application test

Procedure 2: Connector and replacement check

## Procedure 1 Windows Application test

PLS use windows application to check device can work fine or not. If an error is located, go to Procedure 2. If an error is not located, the Bluetooth system is functioning properly.

## Procedure 2 Connector and replacement check

The combine, antenna module or system board may be disconnected or damaged. Disassemble the computer following the steps described in Chapter 4, *Replacement Procedures*, and perform the following checks.

- Check 1 Make sure that the Bluetooth antenna is firmly connected to the Bluetooth module (refer to Chapter 4 for instructions) and that the Bluetooth FFC is securely slotted into the system board. If the problem persists, go to Check 2.
- Check 2 Check that the Bluetooth communication switch is turned to "On", and then make sure that the communication LED on the left panel is lit. If the LED is lit but the Bluetooth function is still faulty, the antenna module may be damaged. Replace with a new antenna following the steps in Chapter 4, *Replacement Procedures*. If the problem persists, or if the Bluetooth communication LED is not lit when the Bluetooth communication switch is turned to "On", go to Check 3.
- Check 3 The Bluetooth module may be damaged. Replace it with a new one following the instructions in Chapter 4. If the problem still exists, perform Check 4.
- Check 4 The system board may be damaged. Replace it with a new one following the instructions in Chapter 4.

## 2.12 SD slot Troubleshooting



Figure 2-11 SD card troubleshooting process

This section describes how to determine if the Bridge Media Slot player is functioning properly. The process is summarized in Figure 2-12. Perform the steps below starting with Procedure 1 and continuing with the other procedures as required.

Procedure 1: SD slot test Procedure 2: Replace SD card to check

## Procedure 1 SD Slot test

The SD test PLS Use windows application to check device can work fine or not. Ensure the card in fully inserted into the socket before running the program.

If an error occurs during the SD test, perform Procedure 2.

## Procedure 2 Replace SD card to check

The test SD card may be damaged or defective, please check the other SD card to test again.

If the system board is defective, it need to be replaced. Replace it with a new one following the instructions in Chapter 4.





Figure 2-12 SDD troubleshooting process

The HDD/SSD or system board may be the reason of a SSD fault. Either of these two

components may be damaged. To determine if the computer's SDD is functioning properly,

perform the following procedures. Figure 2-13 outlines the process. Start with Procedure 1

and continue with the other procedures as instructed.

Procedure 1: Diagnostic test

Procedure 2: Connector and replacement check

\*CAUTION: The Contents of the SSD will be erased when the SSD diagnostic test or formatting is executed. Save the required contents of the SSD to other storage driver in advance.

#### Procedure 1 Diagnostic test

Run the Diagnostic Program, which will automatically execute the SSD R/W test. (Refer to Chapter 3 system configuration check), Tests and Diagnostics for more information the program.

If an error is located, go to Procedure 2. If an error is not located, the SSD function isfunctioning properly.

#### Procedure 2 Connector and replacement check

The HDD module or system board may be disconnected or damaged. Disassemble the computer following the steps described in Chapter 4, *Replacement Procedures*, and perform the following checks.

- Check 1 Make sure that the SSD module is securely slotted into the system board. If the problem persists, go to Check 2.
- Check 2 The SSD module may be damaged. Replace it with a new one following the instructions in Chapter 4. If the problem still exists, perform Check 3.
- Check 3 The system board may be damaged. Replace it with a new one following the instructions in Chapter 4.

## 2.14 HDMI Troubleshooting



Figure 2-13 HDMI troubleshooting process

To determine if the computer's HDMI port is functioning properly, perform the following procedures. Figure 2-14 outlines the process. Start with Procedure 1 and continue as instructed.

Procedure 1: HDMI connection check

Procedure 2: HDMI set check

## Procedure 1 HDMI connection check

The HDMI cable may be damaged or the connections may be loose. Use windows application to check device can work fine or not. Perform Check 1:

- Check 1 Make sure HDMI cable is firmly plugged into both the HDMI set and the HDMI port of the computer. If the cable is connected correctly, go to Check 2.
- Check 2 Make sure the HDMI port is firmly secured to the system board of the computer. If the malfunction remains, go to Check 3.
- Check 3 The HDMI cable may be damaged. Replace with a good cable. If the malfunction remains, go to Procedure 2.

## Procedure 2 HDMI set check

The HDMI TV set may be faulty. Perform Check 1:

- Check 1 Try using the set for television reception. If it does not work, the set may be damaged. If the set does work, perform Check 2.
- Check 2 Try connecting a different television to the computer. If the replacement television works, the original set may be damaged. If the replacement set does not work the system board may be damaged. Replace it with a new one following the instructions in Chapter 4.





Figure 2-14 MIC troubleshooting process

The MIC (camera module) or system board may be the reason of a MIC fault. Either of

these two components may be damaged. To determine if the computer's MIC is

functioning properly, perform the following procedures. Figure 2-15 outlines the process.

Start with Procedure 1 and continue with the other procedures as instructed.

Procedure 1: Windows Application test

Procedure 2: Connector and replacement check

#### Procedure 1 Windows Application test

Run the functioning Program (record.exe) on Windows model, which will display the MIC test result.

If tests and diagnostics result abnormal go to Procedure 2. If an error is not located, the MIC module functioning is properly.

#### Procedure 2 Connector and replacement check

The MIC(camera cable) or system board may be disconnected or damaged. Disassemble the computerfollowing the steps described in Chapter 4, *Replacement Procedures*, and perform the following checks.

- Check 1 Make sure that the MIC cable is securely slotted into the system board. If the problem remains, go to Check 2.
- Check 2 The MIC cable may be damaged. Replace it with a new one following theinstructions in Chapter 4. If the problem still exists, perform Check 3.
- Check 3 The system board may be damaged. Replace it with a new one following the instructions in Chapter 4.

## 2.16 TYPE C Troubleshooting



Figure 2-15 Type C troubleshooting process

Figure 2-17 outlines the process. Perform the steps below starting with Procedure 1 and continue with the other procedures as required.

Procedure 1: USB2.0/3.0 testProcedure 2: Battery Charge checkProcedure 3: HDMI monitor check

## Procedure 1 USB 2.0/3.0 check

First, insert the TYPE C type USB device. Use windows application to check device can work fine or not. If it works, the type C for USB function is OK. If the USB function not work, please replace the USB device to test again, if still no work, please replace the system board.

## Procedure 2 Battery charge check by TYPE C adapter (65W)

Plug in the Type C adapter to system, then check windows system the charge icon is work or not, if it work, the charge function is OK. If the charge function isn't not work, please replace the adapter to test again, if still no work, please replace the system board.

## Procedure 3 HDMI check

Plug in the Type C HDMI to system, then check HMDI monitor is well or not, if HDMI is OK, the function is OK, if no work. Please replace HDMI cable to check again, if still no work please replace the system board.

## 2.17 LAN Troubleshooting



Figure 2-16 LAN troubleshooting process

To determine if the computer's LAN port is functioning properly, perform the following procedures. Figure 2-18 outlines the process. Start with Procedure 1 and continue as instructed.

Procedure 1: Diagnostic check

Procedure 2: Connector and replacement check

#### Procedure 1 Diagnostic check

Run the test and Diagnostics Program, which will automatically execute the LAN Test. Refer to Chapter 3, *Tests and Diagnostics* for more information on how to run the program.

If an error is located, go to Procedure 2. If an error does not occur, the LAN is functioning ok.

## Procedure 2 Connector and replacement check

The LAN cable and/or system board may be disconnected or damaged. Disassemble the computer following the steps described in Chapter 4, *Replacement Procedures* and perform the following checks.

Check 1 Make sure the LAN cable is firmly connected to the LAN port of the system board.

If the connection is loose, reconnect firmly and repeat Procedure 2. If there is still an error, go to Check 2.

- Check 2 The LAN cable may be damaged. Replace it with a new one and repeat Procedure 2. If the problem still exists, perform Check 3.
- Check 3 The system board may be damaged. Replace it with a new one following the instructions in Chapter 4.



## 2.18 Battery Troubleshooting

Figure 2-17Battery troubleshooting process

The Battery or system board may be the reason of a Battery fault. Either of these two

components may be damaged. To determine if the computer's Battery is functioning properly,

perform the following procedures. Figure 2-19 outlines the process. Start with Procedure 1

and continue with the other procedures as instructed.

Procedure 1: Diagnostic test

Procedure 2: Connector and replacement check

## Procedure 1 Diagnostic test

Run the Diagnostic Program, which will automatically execute the Battery test. (Refer to Chapter 3 system configuration check), Tests and Diagnostics for more information on the program.

If an error is located, go to Procedure 2. If an error is not located, the Battery function is functioning properly.

## Procedure 2 Connector and replacement check

The Battery module or system board may be disconnected or damaged. Disassemble the computer following the steps described in Chapter 4, *Replacement Procedures*, and perform the following checks.

- Check 1 Make sure that the Battery module is securely slotted into the system board. If the problem persists, go to Check 2.
- Check 2 The Battery module may be damaged. Replace it with a new one following the instructions in Chapter 4. If the problem still exists, perform Check 3.
- Check 3 The system board may be damaged. Replace it with a new one following the instructions in Chapter 4.





Figure 2-18 LED troubleshooting process

The LED board or system board may be the reason of a LED fault. Either of these two

components may be damaged. To determine if the computer's LED is functioning properly,

perform the following procedures. Figure 2-20 outlines the process. Start with Procedure 1

and continue with the other procedures as instructed.

Procedure 1: Diagnostic test

Procedure 2: Connector and replacement check

## Procedure 1 Diagnostic test

Run the Diagnostic Program, which will automatically execute the LED test. (Refer to Chapter 3 system configuration check), Tests and Diagnostics for more information on the program.

If an error is located, go to Procedure 2. If an error is not located, the LED function is functioning properly.

## Procedure 2 Connector and replacement check

The LED board or system board may be disconnected or damaged. Disassemble the computer following the steps described in Chapter 4, *Replacement Procedures*, and perform the following checks.

- Check 1 Make sure that the LED board FFC is securely slotted into the system board. If the problem persists, go to Check 2.
- Check 2 The LED board may be damaged. Replace it with a new one following the instructions in Chapter 4. If the problem still exists, perform Check 3.
- Check 3 The system board may be damaged. Replace it with a new one following the instructions in Chapter 4.

## 2.20 FAN Troubleshooting



Figure 2-19 FAN troubleshooting process

To determine if the computer's FAN port is functioning properly, perform the following procedures. Figure 2-21 outlines the process. Start with Procedure 1 and continue as instructed.

Procedure 1: Diagnostic check

Procedure 2: Connector and replacement check

## Procedure 1 Diagnostic check

Run the test and Diagnostics Program, which will automatically execute the FAN Test. Refer to Chapter 3, *Tests and Diagnostics* for more information on how to run the program.

If an error is located, go to Procedure 2. If an error does not occur, the FAN is functioning ok.

## Procedure 2 Connector and replacement check

The FAN and or system board may be disconnected or damaged. Disassemble the computer following the steps described in Chapter 4, *Replacement Procedures* and perform the following checks.

Check 1 Make sure the FAN cable is firmly connected to the FAN port of the system board.

If the connection is loose, reconnect firmly and repeat Procedure 2. If there is still an error, go to Check 2.

- Check 2 The FAN may be damaged. Replace it with a new one and repeat Procedure 2. If the problem still exists, perform Check 3.
- Check 3 The system board may be damaged. Replace it with a new one following the instructions in Chapter 4.

## 2.21 Memory Troubleshooting



Figure 2-20 Memory troubleshooting process

To determine if the computer's Memory is functioning properly, perform the following procedures. Figure 2-21 outlines the process. Start with Procedure 1 and continue as instructed.

Procedure 1: Diagnostic checkProcedure 2: Memory replacement check

## Procedure 1 Diagnostic check

Run the test and Diagnostics Program, which will automatically execute the Memory Test. Refer to Chapter 3, *Tests and Diagnostics* for more information on how to run the program.

If an error is located, go to Procedure 2. If an error does not occur, the Memory is functioningok.

## Procedure 2 Memory replacement check

The Memory and or system board may be damaged. Disassemble the computerfollowing the steps described in Chapter 4, *Replacement Procedures* and perform the following checks.

- Check 1 The Memory may be damaged. Replace it with a new one and repeat Procedure 2. If the problem still exists, perform Check 2.
- Check 2 The system board may be damaged. Replace it with a new one following the instructions in Chapter 4.

## 2.22 Finger Print Troubleshooting



Figure 2-21 Finger Print troubleshooting process

To determine if the computer's built-in Finger Print is functioning properly, perform the following procedures. Figure 2-7 outlines the process. Start with Procedure 1 and continue as instructed.

Procedure 1: Diagnostic test in windows systemProcedure 2: Finger Print connection checkProcedure 3: Finger Print replacement check

## Procedure 1 Diagnostic test in TD

Please check Finger Print function in windows system or run the Diagnostic Program, which will automatically execute the FP test. (Refer to Chapter 3 FP check), Tests and Diagnostics for more information on the program.

## Procedure 2 Finger Print connection check

The Finger Print is connected via the FP FFC to the system board. Make sure the FP FFC cable is firmly connected to the FP and system board. Refer to Chapter4, *Replacement Procedures*, for instructions on how to disassemble the computer and then perform the following checks.

If any of the connections are loose, reconnect firmly. If any of the connections is damaged, orthere is still an error, go to Procedure 3.

## Procedure 3 Finger Print replacement check

The Finger Print unit or FPC may be defective or damaged. Replace each with a new one following the steps in Chapter 4. If under windows system test is still not functioning properly, replace the system board with a new one following the steps in Chapter 4.

# Chapter 3

## **Tests and Diagnostics**

3.1	Restore WIM(TD image) to USB driver	
3.2	The Diagnostic Test	
3.3	Executing the Diagnostic Test	
3.4	Display Configuration	
3.5	External Audio Jack Test	
3.6	Speaker Test	
3.7	Touch PAD (Mouse) Test	3-14
3.8	SD Test	3-15
3.9	Web Camera Test	
3.10	Keyboard Test	
3.11	LID Test	
3.12	LED Test	
3.13	Finger Print Test	3-22
3.14	LAN Test	
3.15	Battery Test	
3.16	USB Test	
3.17	TYPEC Test	
3.18	SSD Test	
3.19	RAM Test	
3.20	CMOS (RTC) Test	
3.21	Wireless Card Detect	
3.22	TPM Test	
3.23	FAN Test	
3.24	Exit from TD	

## 3.1 Restore WIM (TD image) to USB driver

## 1. Outline

This document describes How to make TD system to USB driver.

1.1 Target model: C30-K / C40-K / C50-K

**1.2 Target OS:** Windows 11 Pro (Version: 21H2)

## 2. Preparation

2.1 USB 3.0 Memory 32G or 64G, please format to NFTS first.

\*Notice: The USB speed need over 100MB/s as production package display.

Reference: Actual Read speed need over 120MB/s.



2.2 Prepare 1 Notebook (Recommended Configuration: CPU i5 / RAM 16M), then download "rufus-3.19.exe" and "Syrah-v1.WIM" files from FTP to notebook. (You can save to desktop or path C:\ for easy finding)

## 3. Make TD image to USB driver procedure

Step 1: Insert USB drive and launch the Rufus tool (Please "Run as administrator"). Step 2: Click "SELECT" to select image file, like as "Syrah-V1.WIM"

🖋 Rufus 3.19.1911

Recovery (E:) [64 GB]       ✓         Boot selection       Disk or ISO image (Please select)       ✓       Spect ✓       ✓         Partition scheme       Target system       GPT ✓       ✓       ✓         GPT       ✓       UEFI (non CSM)       ✓         * Show advanced drive properties       ✓       ✓         Volume label         Recovery       ✓         File system       Cluster size         NTFS       ✓       ✓         Show advanced format options       ✓         Status	Device				
Boot selection Disk or ISO image (Please select) ✓ ✓ ✓ Partition scheme GPT // Show advanced drive properties Format Options Volume label Recovery File system Cluster size NTFS // Show advanced format options Status READY (LOSE)	Recovery (E:) [64 GB]				$\sim$
Disk or ISO image (Please select)       ✓	Boot selection	•			
Partition scheme Target system GPT UEFI (non CSM) ✓ ✓ Show advanced drive properties Format Options Volume label Recovery File system Cluster size NTFS ✓ ✓ Show advanced format options Status READY (LOSE	Disk or ISO image (Please select)		~ ⊘	SELECT	-
GPT     ✓     UEFI (non CSM))     ✓ <ul> <li>Show advanced drive properties</li> </ul> <ul> <li>Format Options</li> <li>Volume label</li> <li>Recovery</li> </ul> <ul> <li>Cluster size</li> <li>4096 bytes (Default)</li> <li>✓</li> <li>Show advanced format options</li> <li>Status</li> <li>READY</li> <li>Image: Cluster size</li> <li>Cluster size</li> <li>Cluste</li> <li>Cluster size</li> <li>Cluster</li></ul>	Partition scheme		Target system		
Show advanced drive properties  Format Options  Volume label Recovery  File system       Cluster size	GPT	$\sim$	UEFI (non CSM)		$\sim$
Format Options         Volume label         Recovery         File system       Cluster size         NTFS       4096 bytes (Default)            ✓ Show advanced format options         Status         READY            ③ ①          章	<ul> <li>Show advanced drive properti</li> </ul>	es			
Volume label Recovery File system Cluster size NTFS V 4096 bytes (Default) V Show advanced format options Status READY CLOSE CLOSE	Format Options —				
Recovery       File system     Cluster size       NTFS     4096 bytes (Default)       ✓ Show advanced format options       Status         READY         ③ ① 芝 III         Cluster size	Volume label				
File system     Cluster size       NTFS     4096 bytes (Default)       Show advanced format options         Status         READY         ③ ① 毫 国         CLOSE	Recovery				
NTFS ✓ 4096 bytes (Default) ✓ ✓ Show advanced format options  Status  READY  ③ ① 葦 ■ CLOSE	File system		Cluster size		
Show advanced format options       Status	NTFS	$\sim$	4096 bytes (Default)		$\sim$
Status	<ul> <li>Show advanced format option</li> </ul>	15			
READY	Status ———				
READY ③ ① ≋ ■ CLOSE					
⊗ (1) ≋ 🔲 CLOSE		READ	DY		
	∞ ≈ =		<b>.</b>	CI 0.05	
	$\odot \odot \simeq \blacksquare$			CLOSE	

Step 3: After loaded the image file, check the all settings as yellow mark. And then click the "Start" button to start the image deployment process.

	<u> </u>	<b>+</b> _
🖋 Rufus 3.19.1911	- 🗆	$\times$
Daine Base atting		
Drive Properties ———		
Device		
Recovery (E:) [64 GB]		~
Boot selection		
Syrah.wim	SELEC	CT 🔽
Image option		
Windows To Go		~
Partition scheme	Target system	
GPT ~	UEFI (non CSM)	~ ?
<ul> <li>Show advanced drive properties</li> </ul>		
Format Options		
Volume label		
	dog6 bytes (Default)	~
141173	4090 Bytes (Default)	
<ul> <li>Show advanced format options</li> </ul>		
Status ————		
REAI	DY	
& () ≈ Ш	START CLC	SE
Using image: Syrah.wim		

Step 4: Press OK till TIPS (Keeping default setting) close.

Step 5: After finished, please remove USB driver by safety mode.

Step 6: Insert USB driver to debug unit. Then press F12 to select USB driver booting.

## 3.2 The Diagnostic Test

This chapter explains how to use the Test & Diagnostic program to test the functions of the hardware modules. The program consists of a series of tests that run automatically when the Diagnostics Program items are selected and executed.

The TEST & DIAGNOSTIC PROGRAM contains the following functional tests:

- □ CONFIG CHECK TEST
- □ SPEAKER TEST
- □ TOUCH PAD TEST
- □ SD TEST (SD card need use tool to write mark for testing)
- □ WEB CAMERA TEST
- □ KEYBOARD TEST
- □ LID TEST
- □ LED CHECK
- □ FINGER PRINT TEST
- □ BATTERY TEST
- USB PORT TEST
- □ TYPE C TEST
- □ SSD TEST
- □ MEMORRY TEST
- □ CMOS TIME TEST
- □ WL CARD DETECT CHECK
- □ TPM CHECK
- □ FAN TEST

You will need the following equipment to perform some of the Diagnostic test programs.

- □ USB memory
- **TYPE C memory**
- □ Type C adapter (65W)
- $\Box$  AC adapter
- □ Micro SD card
- □ HDMI monitor
### 3.3 Executing the Diagnostic Test

The Diagnostic program is under Windows 11, please install test image to your system for testing.

The test list is as the following:

Fore

□ CONFIG CHECK TEST □ SPEAKER TEST TOUCH PAD TEST □ SD TEST U WEB CAMERA TEST □ KEYBOARD TEST □ LID TEST □ LED CHECK □ FP TEST Back □ BATTERY TEST **USB PORT TEST** □ TYPE C – USB TEST □ SSD TEST MEMORRY TEST □ CMOS TIME TEST

- □ WL CARD DETECT CHECK
- TPM CHECK
- □ FAN TEST

The below display will show up at the beginning of T&D program

Index	Name	
🗆 ltem5	SD test	_
🗖 ltem6	WebCam test	
🔲 ltem7	KB test	
🔲 ltem8	LID function test	
🔲 ltem9	LED test	- 1
🗆 ltem10	FP test	

		🗌 Select All
Index	Name	
🗌 ltem5	Port3 USB2.0(Left)	
🗌 ltem6	Port1_USB3.0(Right)	
🗌 ltem7	Port2_USB3.0(Right)	
🗆 ltem8	Port3_USB3.0(Left)	
🗆 ltem9	TYPEC-USB	
🗌 ltem10	SSD_RW	
🗌 ltem11	RAM test	
🗆 ltem12	CMOSTime test	
🗌 ltem13	WL Detect test	
🗆 ltem14	TPM check	
🗌 ltem15	FAN test	

- Fore: test program under foreground testing. (Sense check by human)
- Back: test program under background testing. (Automatic test)

If the test result passes, the following display will show up:





If an error is detected and a test fails, the following message displays:

#### How to check fail log for detail, please refer to below step.

Step1: Click the stop button when test fail.

		Some beekers	und tooto fail
Test Description	Process	Some backgro	und tests rail,
		Retry	Stop



Exit About		Failed Log	
Foregrand Process           Tail Description         Process           III Undown?rt         (Discord)           Background Process         Tell Description           Tell Description         Process           Tell Description         Process           Tell Description         Process           Tell Description         Process           Tell Description         Process	Windows Test Diagram Microsoft (VTDN Ver 20.0.3,0,000)           Carpose Have: TEST PC           Test Diagram Microsoft (VTDN Ver 20.0.3,0,000)           Windows Test PC           Biologova Microsoft (VTDN Ver 20.0.3,0,000)           Biologova Microsoft (VTDN Ver 20.0.3,0,000)           Tist Several Microsoft (VTDN Ver 20.0.3,0,000)           Biologova Microsoft (VTDN Ver 20.0.3,0,000)           Tist Several Microsoft (VTDN Ver 20.0.3,0,000)           Tist Several Microsoft (VTDN Ver 20.0.3,0,000)           Tist Several Microsoft (VTDN Ver 20.0.3,0,000)           Windows Microsoft (VTDN Ver 20.0.3,0,0,000)           Windows Microsoft (VTDN Ver 20.0.3,0,0,0,0,0,0,0,0,0,0,0,0,0,0,0,0,0,	M TPM check FF	Terrification (Ling) 172234 Lunk
	Total last time: 17 0°	Xem	ErrorCode Log

# 3.4 Display Configuration

This Item will show the unit configuration. It includes:

- CPU (CPU type /Speed)
- DDRAM SIZE
- Panel ID
- HDD1
- VGA CHIP TYPE / VRAM size
- Battery cell
- LAN Type
- MAC
- Wireless type
- Bluetooth
- MBID
- UUID

The screen should display items as below:

CPU Type
RAM Vendor name
RAM Size
RAM Frequency
Manufacturer Name
Manufacturer ID
Product ID
HDD
VGA Type
VRAM Size
Wireless Type
BATT
LanType
Bluetooth
MAC
MBID

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\_

### 3.5 External Audio Jack Test

### Test way by system self without the tool. (No need Audio loopback)

Step 1: Press "Win+S" key to open the search tool then key in "sound settings" to open the "sound settings".



Step 2 Select "More sound settings" from Advanced.



Step 3 Insert earphone (Need support Microphone), the Headphones will be activity as below picture, then click "Headphones"



Step 4 Please select "Advanced" item, then click "Test" button to check the Left/Right channel. (If PASS please

#### click OK button)

leadphones Properties	$\times$
General Levels Advanced Spatial sound	
Default Format Select the sample rate and bit depth to be used when running in shared mode.	
2 channel, 24 bit, 48000 Hz 🗸 🕨 Test	

Step 5 Select "Recording" item, then speech to check the microphone whether increase (please refer to below picture).



### 3.6 Speaker Test

The Speaker test need the user sense the voice to select correct number. And follow below procedures for this test:

- Press Play button to start
- Listen the Left channel to select correct number.
- Listen the Right channel to select correct number.



### Test way by system self without the tool.

Step 1: Press "Win+S" key to open the search tool then key in "sound settings" to open it.



Step 2: click the "More sound settings"

Trou	ubleshoot common sound problems	Output devices	Input devices
0	All sound devices Turn devices on/off, troubleshoot, other options		>
	Volume mixer App volume mix, app input & output devices		>
Mor	re sound settings		C

#### Step 3: click the "Speakers"



#### Step 3: click the "Test" to check left/Right channel.



×

### 3.7 Touch Pad (Mouse) Test

The Touch pad test need user to click & move pad to test, please refer to below step:

Step 1: Move to click area then click left button (PAD)

Touchpad	Time
Click	

Step 2: Slide the Touch PAD & click touch pad Left/Right button. Touchpad

	TP Move		Timer: 13
Left Button		Right Button	

### 3.8 SD TEST

The test will check R/W function, please insert micro SD card to slot for testing. (SD card need write the mark for Compal test tool, please refer to Card Mark SOP)

Please follow below step to check

Step 1: Please run the tool first.

\*Notice: SD card need write the mark by Compal release Card Mark tool.

Step 2: insert SD card, tool will auto test, if PASS SD text will become green

WAIT	
SD	

\*SD card Mark Guideline & Card Mark tool (PW:123)

PDF	
SD Card Mark	Card Marker for
Guideline.pdf	Brazil.7z

# Test way without tool

Step 1: Please insert SD card to system, the system will add SD device as below picture.



Step 2: Please copy file to SD device to check the R/W function whether OK.

### 3.9 Web Camera TEST

Web Camber test need user to check the Camera display whether OK, please refer to below picture, if check PASS please select "Y" for function PASS. (Select N it meaning check fail)



### Test way without tool

Step 1: Press "Win+S" key to open the search tool then key in "Camera" to open it.



1

### 3. 10 Keyboard Test

The keyboard test checks the all keys function.

NOTE: The Num Lock and the Overlay mode must be off to execute the keyboard test.

Before keyboard test starts, the keyboard matrix code should be chosen as below display: (Please select the correct KB region for testing)

- 1. KB JP S/M
- 2. KB US S/M
- 3. KB UK S/M
- 4. **KB JP L**
- 5. **KB US L**
- 6. **KB UK L**

When you execute this test, the keyboard layout is drawn on the display. When any key is pressed, the corresponding key on the screen changes to black as shown below.

	Keyboard Test								Ti	Timer: 18								
ESC	F1	F2	F	3	F4	F5	F6	F7	F8	F	-9	F10	F11	F12	Home	End	INS	DEL
<b>~</b>	!	@ 1	2	#	\$ 3	4	%	5	& 6	7	*	( 8	9	)		-	-	<-BkSp
Tab		۹	W		E	R		т	Y	U		I	o	Р	{	ľ	} ]	۱ ۱
Cap	os	A		S	D		F	G	н		J	к	L	:	;		<-E	nter
LS	Shift		z	х		С	۷	в	N		М	<	,		,	R	Shift P	gUpPgDn
LCtrl	Win	LA	lt								RA	Alt	RCtrl	<-		Up	Dn	~

CE Keyboard

\*US Key sample

## 3. 11 LID Test

This function will check LID (Magnet) function whether OK.

Step 1: Execute test program will show below picture.



Step 2: Close the LCD then open LCD will show PASS as below picture.

PAS	<b>S</b>
No PassC	ode
ОК	S4

# 3. 12 LED Test

This test will check the computer LED status, please follow below step to check:

Step 1: Click the play button.



Step 2: count the Power LED (White) flicker times then select the number. (If fail its

meaning the count wrong number, please re-test again)

LED Test

How many times of Power ON? (Group1, Item1)								
1	2	3						
4	5	6						
7	8	9						
	10							

Step 3: count the Charge LED (White) flicker times then select the number. (If fail its

meaning the count wrong number, please re-test again)

How many times of charge ON? (Group1, Item2)									
2	3								
5	6								
8	9								
10									
	How many times of charge ON? (Group1, Ite 2 5 8 10								

Step 4: count the Discharge LED (Amber) flicker times then select the number. (If fail its

meaning the count wrong number, please re-test again)

LED Test											
How	How many times of discharge ON? (Group2, Item1)										
1	2	3									
4	5	6									
7	8	9									
	10										

### 3. 13 Finger print Test

This function will check Finger print function by system automatic, please follow below step to test.

Step 1: please execute the FP test tool as below picture, then click the start button.

CheckResult		×
	Please put finger to Finger print device	

Step 2: Put finger on FP device, if test OK will show PASS.

### 3. 14 LAN Test

### Test way without tool (No need LAN loopback)

Step 1: Press "Win+S" key to open the search tool then key in "Control panel" to open the "control panel" then select "Network and Internet  $\rightarrow$  Network and Sharing Center"

	Control	pan	el	
All Apps Docu	ments Settings	More ~		
Best match				
Sound settings System settings				
				Sound settings System settings
			🕜 Open	
Part States			0 👻 🍃	

Step 2: Insert LAN cable to system, the Network will show the "Ethernet" as below picture.



### 3. 15 Battery Test

The Battery test checks the battery function by AC adapter or 65W Type C adapter.

Notice: Please make sure BATT capacity under 90% before testing (If BATT capacity is full, this function will test fail)

Step 1: Please insert AC adapter (or 65W TYPE C adapter) Step 2: Please execute Battery tool, system will run automatically.

Background Process	
Test Description	Process
<ol> <li>Battery test</li> </ol>	TB_Battery (1.0.0.9)

\*When block is twinkle by blue color, it meaning testing on going. (PASS will show Green block, fail show Red block)

### Test way without tool

Step 1: Check present Battery Capacity as below picture.



Step 2: Plug in AC adapter or 65w type C adapter, the Battery icon become charge icon as below picture.



Step 3: Waiting 5 minutes to check Battery capacity whether increase. (When charge the LED is amber, if full the LED is white)

### 3. 16 USB Test

This function will check USB2.0/3.0 function whether OK. Please refer to below picture. (Please prepare USB 2.0 & USB 3.0 USB disk in advance)

🗌 ltem6	Port1_USB2.0(Right)
🗌 ltem7	Port2_USB2.0(Right)
🗌 ltem8	Port3_USB2.0(Left)
🗌 ltem9	Port1_USB3.0(Right)
🗌 ltem10	Port2_USB3.0(Right)
🗌 ltem11	Port3_USB3.0(Left)

\*Syrah 10S



Test procedure:

Step 1: Please insert USD disk to test port. (USB port 1 & port 2 in right side, USB port 3 in left side)

Step 2: The system will automatic test by background, if PASS will show below picture.

• Test PASS condition

Background Process			
Test Description	Process		
1. Por2_US82.0(RigH)	TB_AMDUSB3(1.0.0.3)	РА	SS
		No Pas	scode
		ок	<b>S4</b>

#### • Test Fail condition

Background Process			
Test Description	Process		
1. Por2_USI2.0RigH]	T8_AMOUSE3 (1.0.0.3)	Some backgrou try again	and tests fail, now?
		Retry	Stop

### Test way without tool

Step 1: Please insert USB device to system, the system will add USB device as below picture.

0 6 0	<b>e</b>	↑↓ Sort ~ 🛄 V	/iew 🗸 🛆 Ejec			
> This PC >					~ C	Search
V Folders (6)						
				•		
		<b>⊻</b>				
Desktop	Documents ves (3)	Downloads	Music	Pictures	Videos	
Local Disk (C:)	New Volume (D:)	HP x5000m (E:)				
		,				
	C This PC >	<ul> <li>This PC &gt;</li> <li>Folders (6)</li> <li>Deskop</li> <li>Decuments</li> <li>Devices and drives (3)</li> <li>Local Disk (C:)</li> <li>New Yolume (D:)</li> </ul>		Image: Control of the sector of the sect	Image: Constraint of the second s	Image: Contract of the sector of the sec

Step 2: Please copy file to USB device to check the R/W function whether OK.

### 3. 17 TYPE C Test

The Type C test will check USB (by tool)/DP (HDMI) /PD (Charge) function.

#### ■ TYPE C USB test

Step 1: Please insert TYPE C disk to system. Step 2: Please execute Battery tool, system will run automatically.

Background Process	
Test Description	Process
1. TYPEC-USB	TB_AMDUSB3 (1.0.0.3)

\*When block is twinkle by blue color, it meaning testing on going. (PASS will show Green block, fail show Red block)

#### ■ TYPE C DP test

Step 1: Please insert TYPE C w/HDMI dongle to system.

Step 2: Press Key "Win" + "P" (refer to below picture) to select "Duplicate" or "Extend" mode then check HDMI display.



### 3. 18 SSD Test`

The SSD test will check storage device by system automatically.

Step 1: Please execute SSD test tool, system will run automatically.

Background Process	
Test Description	Process
1. SSD_RW	TB_BG_RWStorage (1.0.0.0)

\*When block is twinkle by blue color, it meaning testing on going. (PASS will show Green block, fail show Red block)

### 3. 19 RAM Test

The RAM test will check RAM device by system automatically.

Step 1: Please execute RAM test tool, system will run automatically.

\$
M_SMBIOS (1.0.0.16)

\*When block is twinkle by blue color, it meaning testing on going. (PASS will show Green block, fail show Red block)

### 3. 20 CMOS (RTC) Test

The CMOS test will check CMOS function by system automatically.

Step 1: Please execute CMOS test tool, system will run automatically.

Background Process	
Test Description	Process
1. CMOSTime test	CE_CMOSTime (1.0.0.5)

\*When block is twinkle by blue color, it meaning testing on going. (PASS will show Green block, fail show Red block)

### 3. 21 Wireless Card detect

The WL detect will check WL device by system automatically.

Step 1: Please execute WL test tool, system will run automatically.

Background Process	
Test Description	Process
1. WL Detect test	CE_WLanCardDetect (1.0.0.4)

\*When block is twinkle by blue color, it meaning testing on going. (PASS will show Green block, fail show Red block)

### 3. 22 TPM Test

The TPM test will check TPM device by system automatically.

Step 1: Please execute TPM test tool, system will run automatically.

ackground Process	
Test Description	Process
1. TPM check	TB_DeviceMngr (1.0.0.4)

\*When block is twinkle by blue color, it meaning testing on going. (PASS will show Green block, fail show Red block)

### 3. 23 FAN Test

The FAN test will check FAN function by system automatically.

Step 1: Please execute FAN test tool, system will run automatically.

Background Process	
Test Description	Process
1. FAN test	CE_CMD_RPM_Fan (1.0.0.7)

\*When block is twinkle by blue color, it meaning testing on going. (PASS will show Green block, fail show Red block)

### 3.24 Exit from TD

When you finish test, please move to "Exit" to exit the TD. (Please refer to below picture)

COMPAL - Windows Test   Exit About	DebugSKU	û ↑↓ Sort ~				
		х				
Foreground Process Test Description 1. FP_Test	Process TB_FG_CheckResult (1 0 0 1)	Date modified	Type windows batch File	Size		
		01/15/2022 1:05 AM	WTSB Document	25 KB		
		05/28/2022 4:46 AM	WTSB Document	37 KB		
		01/16/2022 1:05 AM	WTSB Document	4 KB		
		03/31/2021 12:21 PM	Application	32 KB		
Background Process		01/15/2022 2:53 AM	Text Pocument	10 KR		
Test Description Process	01/15/2022 2:12 AM	Winc				
1. FAN test	CE_CMD_RPM_Fan (1.0.0.7)	05/25/2022 9:50 AM	Text			
		05/25/2022 9:50 AM	Text			
		11/19/2013 9:04 AM	Appl			
		06/14/2022 5:01 PM	BINE		PAS	
		06/14/2022 5:01 PM	Conf			
		06/14/2022 5:03 PM	BINE			
		12/23/2009 4:02 AM	Аррі			
		01/17/2022 10:19 PM	WTS		No Pace	Codo
		05/24/2022 12:07 PM	WTSI		NU Pass	COUE
		10/26/2021 8:15 PM	Appl	OK		Shutdown
		03/31/2017 7:01 PM	Text	UN		Shutdown
		02/21/2008 12:26 AM	Application exten	32 KB		

# Chapter-4 Dynabook Replacement Procedures

# Chapter 4 Contents

4.1	General4-5
	Safety Precautions4-6
	Before You Begin4-8
	Disassembly Procedures4-9
	Assembly Procedures4-9
	Tools and Equipment4-10
	Screw Tightening Torque4-10
4.2	Base cover4-11
	Removing the base cover4-11
	Installing the Base Cover4-12
4.3	Battery Pack4-13
	Removing the battery pack4-13
	Installing the Battery Pack4-14
4.4	Fan and Thermal Module4-15
	Removing the Fan and Thermal module4-15
	Installing the thermal Cu-plate4-17
4.5	SSD Card/WLAN Card/DIMM4-20
	Removing the SSD Card/WLAN Card/DIMM4-20
	Installing the SSD Card/WLAN Card/DIMM4-21
4.6	Speakers4-22
	Removing the Speakers4-22
	Installing the Speakers4-23
4.7	IO Board4-24
	Removing the IO Board4-24
	Installing the IO Board4-25
4.8	Sensor Board4-26
	Removing the Sensor Board4-26
	Installing the Sensor Board4-27
4.9	Motherboard4-28
	Removing the Motherboard4-28
	Installing the Motherboard4-29

[CONFIDENTIAL]Satellite C40-K Maintenance Manual

4.10 Finger Print Module4-30
Removing the Finger Print Module4-30
Installing the Finger Print Module4-3
4.11 Touch Pad Module4-32
Removing the Touch Pad Module4-32
Installing the Touch Pad Module4-3
4.12 LCD Assembly4-34
Removing the LCD Assembly4-34
Installing the LCD Assembly4-36
4.13 Bezel
Removing the Bezel4-37
Installing the Bezel4-38
4.14 Panel Assembly4-39
Removing the Panel Assembly4-39
Installing the Panel Assembly4-4.
4.15 Antenna module Assembly4-4
Removing the Antenna module4-4
Installing the Antenna Module4-44
4.16 Camera module Assembly4-4
Removing the Camera Module4-4
Installing the Camera Module4-4
4.17 LCD Hinge
Removing the LCD Hinges4-46
Installing the LCD Hinge4-47
Installing the Panel Assembly4-48

# Figure

Figure 4.2-1 Removing the Base Cover	4-11
Figure 4.3-1 Removing the Battery Pack	4-13
Figure 4.4-1 Removing the Thermal Cu-Plate	4-16
Figure 4.4-2 Removing the Thermal Cu-Plate	4-16
Figure 4.4-3 Fan Cable and WLAN Cable Routing	4-18
Figure 4.4-4 Checking the Thermal Grease on Thermal Cu-Plate	4-19
Figure 4.4-5 Checking the Thermal Pad on Thermal Cu-Plate	4-19
Figure 4.5-1 Removing the SSD Card/WLAN Card/DIMM	4-20
Figure 4.6-1 Removing the speakers	4-22
Figure 4.6-2 Speaker Cable routing channels on upper	4-23
Figure 4.7-1 Removing the IO Board	4-24
Figure 4.8-1 Removing the Sensor Board	4-26
Figure 4.8-2 Removing the release paper of sensor board adhesive	4-27
Figure 4.9-1 Removing the Motherboard	4-28
Figure 4.10-1 Removing the Upper Camera Module	4-30
Figure 4.11-1 Removing the Touch Pad Module	4-32
Figure 4.11-2 Location of Electronic tape & Conductive tape	4-33
Figure 4.12-1 W-LAN / EDP Cables Routing Channels	4-34
Figure 4.12-2 Removing the LCD Assembly	4-35
Figure 4.13-1 Removing the Bezel	4-37
Figure 4.14-1 Removing the Securing tape	4-40
Figure 4.14-2 Disconnecting the Cable from Panel Assembly	4-40
Figure 4.14-3 Disconnecting the Edp Cable FFC from Camera FPC Assembly	4-41
Figure 4.14-4 Removing the Release Paper of Panel Adhesive	4-42
Figure 4.14-5 Panel assembly explanation	4-42
Figure 4.15-1 Removing the Antenna module	4-43
Figure 4.16-1 Removing the Camera Module	4-45
Figure 4.17-1 Removing the LCD Hinge	4-46

### 4.1 General

This chapter explains how to disassemble the laptop and replace Field Replaceable Units (FRUs). Some replacement procedures may not require you to remove all the surrounding FRUs to replace only one FRU. The chart below shows the FRUs in the order in which they should be removed in a top-down manner, irrespective of their physical locations. The FRUs shown in the top area of the chart should normally be removed before removing the FRUs shown in the bottom area. To replace the FRUs, first identify the FRU suspected of the system failure. Next, according to this chart, determine the FRUs that need to be removed before removing the suspect FRU. After you determine those FRUs, go to the appropriate sections according to the section numbers shown in the boxes. Then start removal and replacement.

4.2 Base Cover	]			
4.3 Battery Pack	4.4 Fan and Therm	al Module	4.5 SSD/WI	an/DIMM Module
4.6 Speakers	4.7 IO Board	4.8 Sensor	board	
4.9 Mother Board	4.10 Finger print	Module		
4.11 Touch Pad mod	dule			
4.12 LCD Assembly		$ \Longrightarrow $	For panel	models:
		·	4	.13 B Cover
			4.14	Panel module
7			4.15	Antenna module
			4.16	Camera module
			4.1	7 LCD Hinge

#### **Safety Precautions**

Before you begin disassembly read the following safety precautions carefully. Be sure to follow them while you are working.

#### DANGER:

- 1. Always use the original batteries or replacement batteries authorized by dynabook. Batteries other than those differ in specifications and are incompatible with the laptop. They may burst or explode. To avoid leakage of alkaline solutions, never heat or disassemble the battery packs. Never throw the battery packs into a fire. If this is violated, they will explode.
- 2. The components such as the power supply and inverter carry high voltages. When you partially disassemble the laptop and turn on the components, use extreme care not to touch the connectors and components to avoid the risk of electrical shock. Do not disassemble individual components during first-level maintenance.

#### WARNING:

- 1. To avoid the risk of electrical shock, turn the laptop off and remove the AC adapter from the electrical outlet.
- 2. Because the battery in the laptop is left charged, the risk of electrical shock remains even after the AC adapter is removed from the electrical outlet. To avoid the risk of electrical shock, be sure to remove any metal jewelry or accessories such as necklaces, bracelets and rings before starting work. Never work with damp or wet hands.
- 3. To avoid personal injury, use care to avoid the sharp edges or corners of the components.

#### **CAUTION:**

- 1. Before replacing a component, make sure that the replacement component meets the required specifications. To avoid laptop failures, never use components that do not meet the specifications.
- 2. To avoid internal damage such as short circuits and fire, never drop metal objects such as screws, pins, paper clips, etc. into the components. When a screw is removed, be sure to replace a screw that is the same size as the original screw. Make sure that all the screws are fastened securely. Loose screws can cause short circuits, overheating, smoke or fire.
- 3. Before removing a FRU or other component, make sure that all the component cables have been disconnected to avoid the risk of electrical shock caused by accidental contact with the energized components.
- 4. For AC input, be sure to use the AC adapter and AC power cable that come with your laptop or dynabook-recommended equivalents.
- 5. To avoid the risk of electrical shock, make sure that all the replacement components meet the specifications of the laptop and that all the cables and connectors are fastened securely.
- 6. The components inside the PC become hot during operation (such as the CPU and cooling module). To avoid burns, let the hot components cool down before starting inspection or repair task.

#### **Before You Begin**

Before you begin to disassemble the laptop, keep in mind the precautions and advice in this section. Always begin disassembly by removing the AC adapter and battery pack (need to remove the battery screws first). Remove the optional parts and accessories as well. The procedures for removing the batteries will be explained later.

Disassemble the laptop only when an abnormality has occurred. Use only the recommended

tools.

To run and store the laptop, be sure to prepare a working environment that is free from:

- Dust and contaminants
- □ Static electricity
- □ Extremely high or low temperatures and extremely high humidity

Run the diagnostic tests explained in Chapter 2 of this manual to identify the FRU that has probably caused the system failure.

Perform only the required machine operations. Use only the disassembly and reinstallation procedures described in this manual.

Place the removed components in a safe place away from the laptop so that they are not damaged or get in the way of you doing your work.

Normally, a number of screws need to be removed or replaced during disassembling. Place the removed screws in a safe place so that you can easily find the right screws for the right components.

When assembling the laptop, use the specified screws to fasten the parts to the specified locations. See the appropriate explanations and figures for screw sizes.

To avoid personal injury, use care when handling components that have sharp edges or corners.

After you have replaced a FRU, check that the FRU works correctly to ensure normal laptop operation.

#### **Disassembly Procedures**

The cable connectors come in these three basic types:

- □ Pressure plate connectors
- □ Zero Insertion Force (ZIF) connectors
- □ Normal pin connectors

To remove a pressure plate connector, pull up the tabs on either side of the connector's plastic pressure plate and gently pull the cable out of the connector. To reconnect the cable to the pressure plate's connector, raise the pressure plate up to a satisfactory height and slide the cable into the connector. Secure the cable in the correct position by pressing down the sides of the pressure plate so that the plate is flush with the sides of the connector. Grasp and pull the cable gently to check that the cable is connected firmly. If the cable has come off the connector, reinsert the cable by raising the pressure plate up to a satisfactory height.

To remove a cable from a ZIF connector, pull out the sliders on both sides of the connector and pull the cable out of the connector. To reconnect the cable to the ZIF connector, pull out the sliders on both sides and slide the cable into the connector. Secure the cable in the correct position by pushing in the sliders on both sides of the connector so that the sliders are pushed in securely. Grasp and pull the cable gently to check that the cable is connected firmly. If the cable has come out of the connector, pull out the sliders again and reinsert the cable into the connector to a sufficient depth and push in the sliders until they are pushed in securely.

Normal pin connectors are used for all the other types of cables. These connectors can be installed or removed by simply inserting them or pulling them out.

#### **Assembly Procedures**

You have to reassemble the laptop after you have disassembled the laptop and fixed the component that caused the problem.

When reassembling the laptop, keep the following general guidelines in mind:

- □ Take your time to carry out the suggested instructions completely. Hurried reassembly can often cause problems.
- □ Check that all the cable and connectors are fastened securely.
- □ Before securing the FRUs or other parts, check that the cables are not caught by the screws or FRUs.
- $\Box$  Check that all the latches are closed securely.
- □ Check that all the required screws are used to secure the FRUs. Using wrong screws can damage the threads or heads of the screws or not ensure the FRUs securely.

After installing a FRU, make sure that the FRU and laptop work normally.

#### **Tools and Equipment**

For your safety and that of other people in the working environment, it is strongly recommended that you use electrostatic discharge (ESD) equipment. The proper use of this equipment will ensure successful repair work and reduce the costs for repairing damaged components. The equipment and tools required for disassembly and reassembly are:

- One 2 mm Phillips screwdriver
- One 4 mm flat-blade screwdriver
- □ Torx screw driver
- **T**weezers (for pulling out screws)
- **ESD** mats (for the floor and work desks)
- □ An ESD wrist strap or heel grounder
- □ Anti-static carpets or flooring
- □ Air ionizers (for highly electrostatic sensitive areas)
- □ A plastic card (in credit card size)
- □ A smooth stick (0.43mm, for example: a Pick or PC Mylar)
- □ SIM card tray eject pin tool

#### Screw Tightening Torque

To secure screws, follow the torque values listed below. Over-tightening can damage components and screws. Under-tightening can loosen the screw or cause screws to come off, which may result in short circuits or other damage.

M2×2	0.157-0.205 N·m (1.7-2.0 kgf·cm)
M2×2.5	0.157-0.205 N·m (1.7-2.0 kgf·cm)
M2×3	0.157-0.205 N·m (1.7-2.0 kgf·cm)
M2×5	0.157-0.205 N·m (1.7-2.0 kgf·cm)
M2.5×5	0.270-0.318 N · m (2.75-3.25 kgf · cm)

#### 4.2 Base cover

#### Removing the base cover

Remove the base cover according to the following procedures and Figure 4.2-1.

- 1. Turn the laptop upside down so that the bottom is facing up.
- Remove the six M2x5 screws □,1 and four M2x5 screws □,2 (This four screws have angle to fix D cover)
- 3. Press the cover-edge and pry up the base cover from the inner edges, starting from the top  $\square$ , 3, then

along the sides  $\square$ , 4 and then the bottom  $\square$ , 5.

- 4. Slightly shake the base cover to release the center snap on base cover  $\Box$ , 6.
- 5. Remove the base cover  $\Box$ ,7 as shown in Figure 4.2-1.



Figure 4.2-1 Removing the Base Cover
### **Installing the Base Cover**

Install the base cover according to the following procedures:

- 1. Align the base cover with the snaps on the logic upper assembly, and gently press downward the edges of the base cover until clicks are heard. Make sure all the snaps are latched and secured.
- 2. Tighten the six M2×5 screws  $\square$ ,1 and four M2x5 screws  $\square$ ,2 to secure the base cover to the logic

upper assembly as show in Figure 4.2-1

BIT# of Screw driver	Screw (quantity)	Color	Torque
#1	M2 x 5 mm, flat-head, nylon-coated (10)	Black / Silver	0.181 Nm
			(1.85 kgf-cm)

## 4.3 Battery Pack

### Removing the battery pack

Remove the battery pack according to the following procedures and. Figure 4.3-1

CAUTION:

When handling the battery pack, use cares not to short circuit the terminals. Do not drop, hit, twist or bend the battery pack. Do not scratch or break up their casing.

- 1. Remove the battery cable  $\Box$ ,1.
- 2. Remove the four M2x3 screws  $\square$ ,2.
- 3. Remove the battery pack  $\Box$ , 3.



Figure 4.3-1 Removing the Battery Pack

## **Installing the Battery Pack**

Install the battery pack according to the following procedures:

1. Seat the battery pack in the correct position on the logic upper assembly and press the battery

connector.		,1		,3
------------	--	----	--	----

2. Tighten four M2x3 screws to secure the battery pack to the logic upper assembly.  $\Box$ ,2

BIT# of Screw driver	Screw (quantity)	Color	Torque
#1	M2 x 3 mm, flat-head, nylon-coated (4)	Black	0.181 Nm
			(1.85 kgf-cm)

## 4.4 Fan and Thermal Module

### Removing the Fan and Thermal module

Remove the fan and thermal module according to the following procedures and Figure 4.4-1 & *Figure 4.4-2* 

# CAUTION: When removing the thermal module, keep the following in mind: 1 The thermal module can become very hot during operation. Be sure to let it cool down before . starting the repair work.

1. Peel off the W-LAN Mylar securing the cable connector in place \_\_\_\_\_,1 and disconnect the two

W-LAN antennas (White/Black color) from motherboard , 2 as shown in Figure 4.4-1

- 2. Gently pull up the W-LAN antennas out of the routing channels on fan [],3.
- 3. Disconnect the Fan cable from the motherboard  $\Box$ ,4.
- 4. Remove the two M2x3 screws and fan  $\Box$ ,5.
- 5. Remove the three M2x3 screws according to the number sequence (6->7->8) indicated in Figure 4.4-2
- 6. Remove the thermal module.



Figure 4.4-1 Removing the Thermal Cu-Plate



Figure 4.4-2 Removing the Thermal Cu-Plate

#### Installing the thermal module

Install the thermal Cu-plate according to the following procedures:

1. Seat the fan in the correct position on the logic upper assembly and insert the fan connector  $\Box$ , 1

and tuck the fan cable into the fan hook ,2. as shown in *Figure 4.4-3* 

- 2. Tighten the two M2 x 3 screws to secure the fan to the logic upper assembly in *Figure 4.4-2*, 5
- 3. Check thermal pad is attached on the thermal module as shown in Figure 4.4-4 or Figure 4.4-5
- 4. Place the thermal module in the correct position on the motherboard.
- 5. Tighten the three M2 x 3 screws according to the number sequence (8->7->6) indicated in

Figure 4.4-2 to secure the thermal module to the motherboard.

6. For the W-LAN cable routing, tuck the W-LAN cable into the fan hook ,3, and W-LAN cable connector insert the W-LAN card ,4. Finally, paste W-LAN mylar on the W-LAN module ,5 as shown in *Figure 4.4-3* 



Figure 4.4-3 Fan Cable and WLAN Cable Routing



Figure 4.4-4 Checking the Thermal Grease on Thermal Cu-Plate



Large one is THERMAL PAD-CHOKE (usage : 2 pcs) Small one is THERMAL PAD-MOS (usage : 4 pcs)

Figure 4.4-5 Checking the Thermal Pad on Thermal Cu-Plate

BIT# of Screw driver	Screw (quantity)	Color	Torque
#1	M2 x 3 mm, flat-head, nylon-coated (5)	Black	0.181 Nm
			(1.85 kgf-cm)

## 4.5 SSD Card/WLAN Card/DIMM

### **Removing the SSD Card/WLAN Card/DIMM**

Remove the SSD Card/WLAN Card/DIMM assembly according to the following procedures and Figure 4.5-1

- 1. Remove the one M2x3 screw and WLAN card from the motherboard [1, 1, 2], 2.
- 2. Remove the one M2x3 screw and SSD card from the motherboard  $\Box$ , 3  $\Box$ , 4.
- 3. Remove the DDR shielding and DIMM from the motherboard [,5], 6.



Figure 4.5-1 Removing the SSD Card/WLAN Card/DIMM

### Installing the SSD Card/WLAN Card/DIMM

Install the SSD Card/WLAN Card/DIMM according to the following procedures:

- 1. Seat the WLAN in the correct position and tighten the one M2x3 screws to secure the WLAN to the motherboard assembly. ,1,2,2
- 3. Seat the DIMM in the correct position and seat the shielding cover to the motherboard.  $\Box$ , 5  $\Box$ , 6

## 4.6 Speakers

### **Removing the Speakers**

Remove the speaker assembly according to the following procedures and Figure 4.6-1

- 1. Disconnect the speaker cable from the motherboard  $\Box$ , 1.
- 2. Gently pull up the speaker assembly and the speaker cable out of the routing channels (2->3->4).



Figure 4.6-1 Removing the speakers

#### Installing the Speakers

Install the speakers according to the following procedures:

**NOTE:** Take care not to pinch the cables. Make sure the routing positions of the cables are correct and do not block any components, such as screw holes.

- 1. Seat the speakers in the correct position and secure it in place on the logic upper assembly(2->3->4) as shown in Figure 4.6-1
- 2. Route and secure the speaker cable in the routing channels as shown in Figure 4.6-2
- 3. Connect the speaker cable to the motherboard as shown in Figure 4.6-1  $\Box$ ,1



Figure 4.6-2 Speaker Cable routing channels on upper

## 4.7 IO Board

### **Removing the IO Board**

Remove the IO board according to the following procedures and Figure 4.7-1

- 1. Disconnect the IO board FFC  $\Box$ , 1 $\Box$ , 2.
- 2. Remove two M2x3 screws  $\square$ ,3.
- 3. Gently lift up the right edge of the IO board and remove it from the logic upper assembly  $\Box$ ,4.



Figure 4.7-1 Removing the IO Board

## **Installing the IO Board**

Install the IO board according to the following procedures:

- 1. Seat the IO board in the correct position on the logic upper assembly.  $\Box$ ,4
- 2. Tighten three M2×3 screw to secure the IO board to the logic upper assembly.  $\Box$ ,3
- 3. Connect the IO board FFC to the IO board. Make sure the FFC are properly engaged and firmly

secured.		,2		,1
----------	--	----	--	----

BIT# of Screw driver	Screw (quantity)	Color	Torque
#1	M2 x 3 mm, flat-head, nylon-coated (2)	Black	0.181 Nm
			(1.85 kgf-cm)

## 4.8 Sensor Board

### **Removing the Sensor Board**

Remove the Sensor board according to the following procedures and Figure 4.8-1

- 1. Disconnect the sensor board FFC [1, 1], 2.
- 2. Gently pry up the sensor board from the adhesive and remove it from the Upper cover  $\square$ , 3.



Figure 4.8-1 Removing the Sensor Board

### **Installing the Sensor Board**

firmly secured. 3, 3, 2, 2, 1

Install the Sensor board according to the following procedures:

- 1. S eat the sensor board in the correct position and secure it in place with adhesives on the upper cover as shown in Figure 4.8-2
- 2. Connect the sensor board FFC to the sensor board. Make sure the FFC are properly engaged and



Figure 4.8-2 Removing the release paper of sensor board adhesive

## 4.9 Motherboard

#### **Removing the Motherboard**

Remove the motherboard according to the following procedures and Figure 4.9-1

1. Disconnect the FP FFC 1,1,2 / IO FFC 3,3,4 / Keyboard FPC 5,5,6/TP FFC

1,7,7,8 / Sensor FFC 1,9,7,10 / EDP cable 1,11 / DCIN cable 1,12 from the

motherboard as shown in Figure 4.9-1

- 2. Remove four M2x3 screws  $\Box$ , 13 securing the motherboard to the logic upper assembly
- 3. Gently lift the left edge of the motherboard and remove the motherboard from the logic upper assembly ,14.



Figure 4.9-1 Removing the Motherboard

#### Installing the Motherboard

Install the motherboard according to the following procedures:

- 1. Seat the motherboard in the correct position on the logic upper assembly.  $\Box$ ,14
- 2. Tighten four M2x3 screws to secure the motherboard to logic upper assembly as shown in

Figure 4.9-1 ,13

3. Connect the EDP cable 1,11 / DCIN cable 1,12 / sensor board FFC 9,9,10 / TP FFC

3,7,8,8 / Keyboard FPC 5,5,6,6 / IO FFC 3,3,4,4 / FP FFC 1,1,2,2 to the

motherboard as shown in Figure 4.9-1. Make sure the FPC and the connectors are properly engaged and firmly secured .

BIT# of Screw driver	Screw (quantity)	Color	Torque
#1	M2 x 3 mm, flat-head, nylon-coated (4)	Black	0.181 Nm (1.85 kgf-cm)

## 4.10 Finger Print Module

### **Removing the Finger Print Module**

Remove the finger print assembly according to the following procedures and Figure 4.10-1

- 1. Disconnect the finger print FFC from finger print module [1, 1], 2.
- 2. Remove the one M2x2 screw securing the finger print bracket to the logic upper assembly.  $\Box$ , 3
- 3. Remove finger print bracket  $\Box$ ,4 from the logic upper.
- 4. Gently push the finger print module away from the logic upper assembly  $\Box$ , 5.



Figure 4.10-1 Removing the Finger print Module

## **Installing the Finger Print Module**

Install the finger print module according to the following procedures:

- 1. Seat the finger print in the correct position on the logic upper assembly  $\Box$ ,5.
- 2. Place the finger print bracket on the logic upper assembly  $\Box$ ,4.
- 3. Tighten one M2×2 screw to secure the finger print bracket to the logic upper assembly  $\Box$ , 3.

Connect the finger print FFC to the finger print  $\Box$ , 1 $\Box$ , 2.

BIT# of Screw driver	Screw (quantity)	Screw (quantity) Color	
#1	M2 x 2 mm, flat-head, nylon-coated (1)	Black	0.181 Nm
			(1.85 kgf-cm)

## 4.11 Touch Pad Module

### **Removing the Touch Pad Module**

Remove the touch pad assembly according to the following procedures and Figure 4.11-1 and Figure 4.11-2

- 1. Disconnect the finger print FFC from finger print module  $\Box$ , 1 $\Box$ , 2.
- 2. Peel away the conductive tape  $\Box$ , 6 on logic upper assembly from touch pad.
- 3. Remove the two M2x2 screws securing the TP support bracket to the logic upper assembly  $\Box$ , 3.
- 4. Remove TP support bracket  $\Box$ ,4 from the logic upper.
- 5. Gently push the touch pad away from the logic upper assembly [,5.



Figure 4.11-1 Removing the Touch Pad Module



Figure 4.11-2 Location of Electronic tape & Conductive tape

### **Installing the Touch Pad Module**

Install the touch pad module according to the following procedures:

- 1. Seat the touch pad in the correct position on the logic upper assembly.  $\Box$ ,5
- 2. Seat the TP support bracket in the correct position on the logic upper assembly  $\Box$ , 4 and tighten

two M2×2 screws to secure the tp support bracket to the logic upper assembly.  $\Box$ ,3

- 3. Connect the touch pad FPC to the touch pad.  $\Box$ , 2 $\Box$ , 1
- 4. Adhere the conductive tape over the touch pad and logic upper assembly as shown in Figure 4.11-2

Π.6
-----

BIT# of Screw driver	Screw (quantity)	Color	Torque
#1	M2 x 2 mm, flat-head, nylon-coated (2)	Black	0.181 Nm
			(1.85 kgf-cm)

## 4.12 LCD Assembly

#### **Removing the LCD Assembly**

Remove the LCD assembly according to the following procedures and Figure 4.12-1and Figure 4.12-2

1. Pull the W-LAN cables and EDP cable out of the routing channels as shown in Figure 4.12-1 \_\_\_\_,1



- 2. Remove the six M2x5 screws  $\Box$ , 3 securing the LCD assembly as shown in Figure 4.12-2
- 3. Make sure all cables are moved away from the logic upper assembly to avoid damaging the system when removing the LCD assembly. Lift away the LCD assembly from the logic upper assembly as the

arrow ,4 indicates in Figure 4.12-2



Figure 4.12-1 W-LAN / EDP Cables Routing Channels



Figure 4.12-2 Removing the LCD Assembly

### Installing the LCD Assembly

**NOTE:** Take care not to pinch the antenna cables. Make sure the routing positions of the antennas are correct and do not block any components, such as screw holes.

Install the LCD assembly according to the following procedures:

- 1. Place the logic upper assembly upside down so that the bottom is facing up.
- 2. Rotate the LCD hinges to a 180-degree angle and seat the LCD assembly in the correct position on the logic upper assembly, and the cables must be placed inside the hook of hinge bracket. ,4
- Tighten the six M2.5×5 screws to secure the LCD assembly to the logic upper assembly as shown in Figure 4.12-2 ,3

Route and secure the W-LAN and EDP cable in the routing channels on the logic upper assembly as shown in Figure  $4.12-1\Box$ ,  $2\Box$ , 1

BIT# of Screw driver	Screw (quantity)	Color	Torque
#1	M2.5 x 5 mm, flat-head, nylon-coated (6)	Silver	0.294 Nm
			(3.0 kgf-cm)

## 4.13 Bezel

### **Removing the Bezel**

Remove the Bezel according to the following procedures and Figure 4.13-1

- 1. Place the LCD assembly right-side up so that the top is facing up.
- Insert a smooth, flat instrument into the gap between the Bezel and the LCD cover as shown in Figure 4.13-1 and then gently twist the instrument to pry up the Bezel from the LCD cover 
   ,1.



Figure 4.13-1 Removing the Bezel

## Installing the Bezel

Install the Bezel according to the following procedures:

- 1. Place the Bezel on the LCD cover assembly. Make sure the tabs on the back of the Bezel align with the slots in the LCD cover assembly.
- 2. Gently press down edges around the Bezel until clicks are heard. Make sure all the snaps are latched and secured.

## 4.14 Panel Assembly

#### **Removing the Panel Assembly**

Remove the panel Assembly according to the following procedures and Figure 4.14-1 and Figure 4.14-2 and Figure 4.14-3

- 1. Pull up the tape from LCD cover  $\Box$ , 1 as shown in Figure 4.14-1
- Carefully lift up and rotate the panel from the LCD assembly as the arrow ,2 indicates in Figure 4.14-1
- 3. Place the panel on a protective surface, such as a foam pad as shown in Figure 4.14-2
- 4. Peel the conductive tape ,3 on EDP cable connector so that the connector are visible as shown in Figure 4.14-3
- 5. Pull the lock bar outward and disconnect the EDP cable from the touch glass panel ,4 as shown in Figure 4.14-2
- 6. Disconnect the EDP cable FFC from Camera FPC (5->6->7) and Gently pry up the Camera FPC □,8 as shown in Figure 4.14-3
- 7. Peel away the EDP cable  $\Box$ ,9 on LCD cover assembly in Figure 4.14-3



Figure 4.14-1 Removing the Securing tape



Figure 4.14-2 Disconnecting the Cable from Panel Assembly



Figure 4.14-3 Disconnecting the Edp Cable FFC from Camera FPC Assembly

### **Installing the Panel Assembly**

Install the panel assembly according to the following procedures:

- 1. Place the panel assembly upside down so that the bottom is facing up.
- 2. Connect the EDP cable to the panel connector and lock it with lock bar, then adhere the mylar over the connector to secure it in place as shown in Figure 4.14-2 , 3, 4
- 3. Connect the EDP cable FFC to the camera FPC board connector as shown in Figure 4.14-3 (9->8->7->6->5)
- 4. Pull up the blue release paper of Panel Adhesive from LCD cover as shown in Figure 4.14-4 , 1

5. Rotate the panel right-side up and use 0.5mm Mylar between LCD cover and Panel to seat it in the

correct position as shown in *Figure 4.14-5*  $\square$ ,2



Figure 4.14-4 Removing the Release Paper of Panel Adhesive



Figure 4.14-5 Panel assembly explanation

## 4.15 Antenna module Assembly

#### **Removing the Antenna module**

**NOTE:** Antenna module is fastened by adhesives. Remove it slowly and carefully.

Remove the Antenna module according to the following procedures and Figure 4.15-1

- 1. Removing the Antenna cable from the adhesive and remove it from the Hinge [, 1]
- 2. Gently pry up the Cu-Foil from the adhesive and remove it from the LCD cover  $\Box$ , 2.
- 3. Removing the Antenna module from the adhesive and remove it from the LCD cover  $\Box$ , 3
- 4. Removing the Antenna module cable from the LCD cover  $\Box$ ,4
- 5. Gently pry up the Cu-Foil from the adhesive and remove it from the LCD cover [, 5],
- 6. Removing the Antenna module from the adhesive and remove it from the LCD cover  $\Box$ ,6



Figure 4.15-1 Removing the Antenna module

#### **Installing the Antenna Module**

Install the Antenna module according to the following procedure:

- 2. Pasting the module-Aux Cu-Foil in the correct position.  $\Box$ ,5
- 3. Seat the Antenna cable in the correct position and secure it in place.  $\Box$ ,4
- Seat the Antenna module-Main in the correct position and secure it in place with adhesives behind it. □,3
- 5. Pasting the module-Main Cu-Foil in the correct position.  $\Box$ ,2
- 6. Seat the Antenna cable in the correct position and secure it in place with adhesives behind it.

## 4.16 Camera module Assembly

### **Removing the Camera Module**

**NOTE:** Camera module is fastened by adhesives. Remove it slowly and carefully.

Remove the camera module according to the following procedures and Figure 4.16-1

- 1. Gently pry up the camera module and remove it from the LCD cover  $\Box$ , 1.
- 2. Remove Mic rubber  $\square$ , 2 from the camera module.



Figure 4.16-1 Removing the Camera Module

#### **Installing the Camera Module**

Install the camera module according to the following procedure:

1. Seat the mic rubber in the correct position and secure it in place with adhesives behind it.

,2

- 2. Seat the camera module in the correct position and secure it in place with adhesives behind it.
  - ,1

## 4.17 LCD Hinge

### **Removing the LCD Hinges**

Remove the LCD hinges according to the following procedures and Figure 4.17-1

- 1. Remove the six M2x2.5 screws securing the LCD hinges  $\Box$ ,1.
- 2. Remove the two M2x3 screws securing the LCD hinges  $\Box$ ,2.
- 3. Remove the LCD hinge ,3.



Figure 4.17-1 Removing the LCD Hinge

## Installing the LCD Hinge

Install the LCD Hinge according to the following procedures:

- 1. Seat the LCD hinge in the correct position on the LCD cover assembly.  $\Box$ ,3
- 2. Tighten the six M2x2.5 screws to secure the LCD hinges to the hinge cover assembly.  $\Box$ ,1
- 3. Tighten the two M2x3 screws to secure the LCD hinges to the hinge cover assembly.  $\Box$ ,2

BIT# of Screw driver	BIT# of Screw driver Screw (quantity)		Torque
#1	M2 x 2.5 mm, flat-head, nylon-coated (6)	Black	0.181 Nm
			(1.85 kgf-cm)
#1	M2 x 3 mm, flat-head, nylon-coated (2)	Black	0.181 Nm
			(1.85 kgf-cm)
## **Installing the Panel Assembly**

Install the panel assembly according to the following procedures:

- 1. Seat and adhere the Hinges in the correct position on the LCD cover assembly as shown in Figure 4.17-1 (Tighten the six M2×2.5 screws).
- 2. Seat and adhere the antennas in the correct position on the LCD cover assembly as shown in Figure 4.17-1 (. (Tighten the two M2×3.0 screws)
- 3. Seat and adhere the Camera in the correct position on the LCD cover assembly as shown in Figure 4.16-1
- 4. Seat and adhere the Antenna module in the correct position on the LCD cover assembly as shown in Figure 4.15-1
- 5. Place the panel assembly upside down so that the bottom is facing up.
- 6. Connect the EDP cable to the panel connector and lock it with lock bar, then adhere the mylar over the connector to secure it in place as shown in Figure 4.14-2
- 7. Connect the EDP cable FFC to the camera FPC board connector as shown in Figure 4.14-3
- 8. Pull up the blue release paper of Panel Adhesive from LCD cover as shown in Figure 4.14-4
- 9. Rotate the panel right-side up and use 0.5mm Mylar between LCD cover and Panel to seat it in the correct position as shown in *Figure 4.14-5*